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SURVEY OF ORGANIC SEMICONDUCTORS INCLUDING ELECTRICAL AND MECHANICAL PROPERTIES OF PLASTICS

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TECHNICAL REPORT AFFDL-TR-68-68

JUNE 1968

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FOREWORD

This report was prepared by the University of Dayton Research Institute, Dayton, Ohio, under Contract AF 33(615)-2674 with the Air Force Flight Dynamics Laboratory, Wright-Patterson Air Force Base, Ohio. This research was performed under Program Element 6. 16. 46. 01. D. in support of Project 1473 Task 147301. Dr. W. A. Kapp (FDTR) was the Air Force Project Monitor. The research reported herein was performed during the period 16 May 1967 through 30 November 1967 and the report was submitted 13 December 1967. Principal investigator was Dr. John H. Meiser, Assistant Professor of Chemistry, University of Dayton.

This technical report has been reviewed and is approved.



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Chief, Theoretical Mechanics Branch
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ABSTRACT

A comprehensive list of organic semiconductors has been prepared to include compounds having resistivities in the range 10^{-3} to 10^{20} ohm cm. Where electrical and mechanical properties were found, they were included. Five classes of compounds were reviewed and ten compounds were suggested as displaying electrical hysteresis effects due to mechanical loading. Included in the tables is a listing of physical properties of commercially available plastics.

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INTRODUCTION

The following report was designed as a literature survey of organic semiconductors and as a compilation of their electrical, mechanical, and chemical properties. Included in the report are commercially available plastics whose resistivities place them near the low end of compounds considered as semiconductors.

This report is divided into two sections: Part I is a listing of the above properties, and Part II is a discussion of these properties with regard to electrical hysteresis due to mechanical loading.

PART I Review of Published Data

In terms of conductance, an organic semiconductor is found normally with a conductivity $(\text{ohm cm})^{-1}$ between 10^2 and 10^{-14} . Its carrier concentration, either p-type or n-type, will typically be in the range of 10^6 to 10^{19} carriers per cm^3 . The mobility, μ (a measure of the ease with which the carriers pass from one molecule to the next), will be found between 10^2 and 10^{-6} $\text{cm}^2 \text{ volt}^{-1} \text{ sec}^{-1}$. The above quantities, when compared to values for a typical metal, are found to be 10^2 to 10^8 $(\text{ohm cm})^{-1}$, 10^{22} carriers per cm^3 , and $10^3 \text{ cm}^2 \text{ volt}^{-1} \text{ sec}^{-1}$, respectively. Thus, we have the distinction between organic semiconductors and metals and a general idea of their relationships with regard to these quantities.

However, Pohl¹⁴⁰ states that a substance should show six properties in order to be listed as an organic semiconductor:

- (1) Conductivity in the range 10^{+4} to 10^{-12} $(\text{ohm cm})^{-1}$;
- (2) Negative temperature coefficient of resistance;
- (3) Conductivity sensitive to impurity concentrations;
- (4) Usually a high thermo-electric power;
- (5) Rectification or at least non-ohmic behavior at junctions;
- (6) Photo-sensitivity.

Unfortunately, many of the compounds of interest to us have not been studied enough to yield sufficient data to allow their classification according to Pohl's definition - particularly with regard to the last five properties. Therefore, we will list all compounds as semiconductors when their conductivities fall into the above range. For the sake of completeness, many compounds with conductivities down to 10^{-18} $(\text{ohm cm})^{-1}$ will also be listed.

Concepts and Symbols

The conductivity of substances as appears in the tables obeys an equation of the form

$$\sigma = \sigma_0 e^{(-E/2kT)} \quad (1)$$

over some range of temperature,

where: σ = conductivity, $(\text{ohm cm})^{-1}$

σ_0 = constant

E = energy gap

T = temperature

k = Boltzmann's constant.

In general, the exponential factor determines the temperature dependence and arises from the exponential increase in probability that charged carriers are thermally liberated across a potential barrier. But depending on the envisaged mechanism for the liberation, a thermal term can be contributed to σ_0 .

It may be shown¹⁴¹ that an equation for conductivity in the form

$$\sigma = \sigma_0(T) \exp(-E/kT) \quad (2)$$

can give rise to Equ. 1 where $\sigma_0(T)$ represents any function of T , subject to certain conditions. Thus, the experimental value of E may be temperature independent only approximately. Thus, before experimental results can be

theoretically evaluated, an assumption as to the manner of charge transport must be made. Such descriptions are outside the purpose of this survey and the interested reader is directed to the many books which discuss this problem^{77, 142, 143, 145}

The reader is cautioned in comparing the data which appears here and those in the original literature. The energy term for Eqn. 1 often appears in several different forms: $E/2kT$, E/kT , or E/RT . In E/RT , E is expressed in kilocalories per mole and has the numerical value of $\frac{2E}{23}$ electron volts. In our listings, all entries are made to conform to the first expression, $E/2kT$, and are in electron volts.

For convenience, instead of listing conductivity, we will list the specific resistance. This is easily accomplished since

$$\sigma = 1/\rho \quad (3)$$

where ρ is the specific resistance. Then Eqn. 1 can be rewritten as

$$\rho = \rho_0 e^{E/2kT} \quad (4)$$

Thus, the values of ρ and E in the following tables will conform to the above Eqn. 4. Rather than continue a discussion of the various entries here, the meaning of the entries should be clear from the tables.

Compilation Coverage

These tables were obtained by a thorough search of the physics and chemistry literature, including publications in chemical engineering. The search was performed with one computerized search and by manual searching. Manual searching was found to be far more suitable for finding data. This is due in part to the fact that chemical literature has not been thoroughly computerized. The major source searched was Chemical Abstracts. Indeed, cross-checking of references at the end of individual

papers insured also the inclusion of those references if not entered into the Chemical Abstracts. The search includes data published up to June, 1967.

In view of the second part of this paper, a few substances which were found with very high specific resistance (low conductivities) 10^{16} or larger, were eliminated from the tables since they fall far outside the limits set for organic semiconductors. No deletions in the opposite direction (low resistivity) were made.

Manner of Presentation

In order to facilitate the listings, the compounds have been divided into a number of sections following that of Gutmann and Lyons¹⁴². This division depends partially on the substances' nature and partially on the manner of their occurrence. Although there is a section on biological materials, some of these materials may be listed under molecular crystals because they occur in nature as crystals or because of the major work performed on them as molecular crystals.

Each compound as appears in the table is listed in alphabetical order and accompanied by the value of its (room temperature) resistivity, temperature range to which the resistivity is applicable, and the energy gap.

PART II Criticism of Data and Recommendations

Review of the Data

The first thing which we note about the tables in this report is the lack of data. The lack of data present is due to several things. Primary among these is that for most of the compounds listed, engineering data simply do not exist. It was decided to compile, at first, as complete a list of organic semiconductors as possible without regard to their mechanical properties and then to add the mechanical properties as far as available.

Although a value appears for the resistivity of a particular compound, the data cannot be accepted without a critical review of the techniques used to obtain the data. Thus, some authors do not list the methods used in the resistivity determination. Other authors do not take into account space-charge considerations, or the effect of the contacts used in their particular method. Rust and others⁽⁶³⁾ describe some of the dangers involved in using the most simple techniques for contacts and encapsulation of the sample material. It is often found that the temperature or pressure (in compacting samples) is inadequately controlled or not reported. In view of these short comings, the tables of data were reported without critical evaluation of the methods used to obtain the data.

Another problem presents itself in the task of collecting data for many of these compounds.

If the above tables are carefully examined and checked with the original literature, it is seen that many of the compounds were first prepared by the researchers reporting the compounds' resistivity. Quite often, the total yield of such reactions is a few tenth of a gram of product. When the investigator did not find the particular effect desired for this investigation, the compound often no longer was investigated. Thus, automatically, one would not expect much data to be available on these compounds. When data

are available, they are included. Thus, commercial plastics have a special table devoted to their physical properties. These data normally are given with a range of values of their physical properties since samples from different commercial suppliers will generally vary.

One will also note that most of the compounds in this table lay outside the resistivity range given by Pohl as appropriate to organic semiconductors. Their inclusion, especially with regard to polymers, was done to present a more complete list of compounds upon which work has been done.

Normally, the procedures for preparing the compounds presented in this survey will be found in the journal article referenced. This is not true for the commercially available plastics whose actual preparation is normally proprietary information.

Compounds Exhibiting Hysteresis

One of the most interesting compounds to come to the attention of this investigation is not even listed as having a determined resistivity in the tables. However, its properties are such that it should be investigated both for possible semiconducting properties and also for resistive or dielectric hysteresis. This organic molecular crystal is thiourea ($\text{CH}_4\text{N}_2\text{S}$). At normal temperature and pressure the crystal belongs to the orthorhombic centrosymmetric group $D_{2h}^{16}(\text{P}_{nma})$ with four molecules in the single crystal. Bridgman⁽²³⁹⁾ investigated the phase diagram for thiourea. Extrapolation of his data gives a transformation at 25°C of 3460 kg/cm^2 . Leonidova⁽²³⁸⁾ found that a first-order transformation occurs in thiourea under a pressure of 4000 kg/cm^2 between 18 and 74°C . Thiourea has ferroelectric properties along the 010 axis at temperatures below 169°K and between $+76$ and 180°K . At all other temperatures between 90 and 300°K the crystal is antiferroelectric and the phase transition involves a change from one state to the other at high pressures. The important thing to our discussion is that ferroelectric

properties of the samples may be measured by a hysteresis loop which forms with a change in pressure. Leonidova⁽²³⁸⁾ also found after 2 - 3 cycles of increase and decrease of pressure, his single crystal of thiourea broke. Single crystals can be grown by evaporating the solvent from a saturated solution of thiourea in methyl alcohol. The thiourea is commercially available. Samples used in the above work were 7 x 5 x 1 mm.

Other compounds have not yet been investigated for possible first-order transitions to be used in the same manner as thiourea. However, two other compounds show hysteresis loops of sufficient size that a change may easily be recorded. Pyranthrone shows a resistivity versus temperature hysteresis. Ferrocene, on the other hand, has a resistivity versus pressure relaxation. In this case the changing parameters appear to be due to a mechanical lengthening and shortening of the intermolecular bands. Ferrocene has a resistivity in the order of 10^7 ohm cm and thermoelectric power + 1.2 - 1.6 mV/deg. It is found that the resistance normally decreases with increasing pressure reaching a minimum at 5000 atm. followed by an increase with increasing pressure. This is a reversible process except for the hysteresis and is not due to polymorphic change. References 231, 229, 230, and 63 are specific papers on ferrocene or related compounds. References 77 and 142 are more general references treating ferrocene.

Polymers

Several classes of polymer compounds should be mentioned at this point. Charge transfer complexes, in general, can be stable and may display hysteresis. However, the whole set of hydrocarbon/halogen complexes seems to be stable only under their vapor pressure. They are sensitive to air and to water and thus appear unsuitable to applications where they are in contact with these substances. The reason this set is mentioned is because of their rather low resistivities.

The second set which should be mentioned is the phthalocyanines in combination with various metals⁽²⁴⁰⁾. There does not appear to be any hysteresis but these compounds do show stability. Their crystalline and electrical properties are similar to anthracene exhibiting low carrier mobilities and high electrical resistivity.

Anion-radicals of tetracyanoquinodimethane normally have crystals which are weak and brittle⁽³³⁾. However, low - and intermediate - conductivity compounds often are relatively easily obtained in the form of single - crystals, while high-conductivity materials come out of solution in the form of small needles. Compounds of the type $M+(TCNQ)^{-}_{1.5}$ and $M+(TCNQ)^{-}_2$ on heating dissociate into $M+(TCNQ)^{-}$ and free TCNQ while compounds of the type $M+(TCNQ)^{-}$ decompose before melting. This class of compounds does not show hysteresis.

Finally, there exist a large number of condensation products which would normally be considered as polymers in the normal sense of the word. Here again there appears to be few reasons to pick one over any other.

For the sake of argument, I would pick the following one or more from the above sets to begin work upon.

Charge-Transfer Compounds

(1) Azulene : Tetracyanoethylene $\rho = 4.7 \times 10^{10}$ ohm·cm

1:1 complex made by dissolving equal molar quantities of azulene and TCNE in ether and slowly evaporate solvent. TCNE is available from Eastman and azulene from Rutgerswerke-AG.

Reference 6.

(2) Cobaltocene : Chloranil $\rho = 2.05 \times 10^4$ ohm·cm

Press versus ρ data given

Reference 73.

(3) Dibenzo [c, d] phenothiazine:

2, 3 - dichloro - 5, 6 - dicyano - p - benzoquinone

2:1 $\rho = 17$ ohm·cm

1:1 $\rho = 5 \times 10^3$ ohm·cm

For starting material see: Reference 241.

Reference 2.

(4) p - Phenylenediamine : Chloranil $\rho \approx 10^6$ ohm·cm

Seebeck coefficient : 1.1×10^{-3} V/deg.

Thermal conductivity : 2.0×10^{-3} w cm⁻¹ deg⁻¹

Chloranil is available from Eastman.

K&K handles p-phenylenediamine.

Reference 167, 6, 62, 233, 1, 27.

Phthalocyanine

(1) Cu phthalocyanine $\rho \approx 10^{12} - 10^{13}$

References 41, 81, 142, 144, 77. The last three give many more references.

Anion-Radicals of Tetracyanoquinodimethane

(1) Diaminodurene (7, 7, 8, 8 - tetracyanoquinodimethane)₂

$\rho = 2$ ohm·cm

Reference 33.

(2) N-methylquinolinium (7,7,8,8-tetracyanoquinodimethane)₂

single crystal $\rho = 0.01 \text{ ohm} \cdot \text{cm}$

compacted $\rho = 2.0 \sim 10.0 \text{ ohm} \cdot \text{cm}$

Reference 33.

Condensation Products

(A) Polyacenequinone Radical Polymers

(1) Anthraquinone, pyromellitic anhydride, Zn Cl₂

3:1:2 $\rho = 2.0 \times 10^4 \text{ ohm} \cdot \text{cm}$

Reference 75.

(2) Pyrene, pyromellitic dianhydride $\rho = 2.58 \times 10^4$

Material is insoluble and infusible - slight
thermoplasticity allows compacting. It is
swellable by acetone.

Reference 25.

(3) Pyrene, p-fluorobenzoic acid, Zn Cl₂ (catalyst)

1:1:1 $\rho = 7.8 \times 10^4 \text{ ohm} \cdot \text{cm}$

Reference 55.

PART III - TABLES

TABLE I

METAL-FREE MOLECULAR CRYSTALS

Substance	ρ ohm. cm	Temp °C	E in $2/kT$	Sign of Major- ity Carrier
Acenaphthene	10^{14}	60	2.0	
3-Acetylamino-N-methyl-phthalimide	10^{14}	97	3.46	
3-Acetylamino-N-penyl-phthalimide	10^{14}	67 to 100 54 to 124	3.46 3.50	
Anils, substituted	10^{11} to 10^{15}		1.9 to 6.5	
Acridine, i. e., (2, 3-benzo-quinoline)	5.6×10^{17}		5.02 0.66	
Anthracene				
Lab (single crystal)	7×10^{15}		1.66	
Lab (single crystal)	10^{19}	30 to 70	1.94	
Lab (single crystal)	1.35×10^{14}	80 to 200	1.66	
(single crystal)	10^{22}	80 to 200	2.7	
(single crystal)	$1 \text{ to } 3 \times 10^{17}$			
(single crystal)	10^{14}	20 to 60	1.5	

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Anthracene, (cont.) (single crystal) (compacted)	> 1015	0.5	+		145
	1014 at 200°C	160 to 210	2.92		142
(single crystal) (single crystal)	1018	80 to 150	1.74±0.6		177
	1.5x10 ¹¹ (Cu) contacts			Mobility $\geq 2.3 \text{ cm}^2/\text{V} \cdot \text{sec}$	178
(single crystal) (compacted)	> 1.5x10 ¹¹ (Al) contacts			Mobility 0.8 $\text{cm}^2/\text{V} \cdot \text{sec}$ (ref. 291)	178
	1015	160 to 217	2.92		
For additional data, see v.					
Anthanthrene	1018	40 to 105	1.6		Ref. 270: ionization pot. = 7.01e.v.
(evaporated) (single crystal)	1.5x10 ⁹	25 to 90	1.67		76
	1x10 ¹³	25 to 90	1.60	$\rho_o = 1 \times 10^4$	191
			1.58	$\rho_o = 2$	12
Anthanthrone	7.7x10 ¹⁸	40 to 150	1.70	$\rho_o = 10^4 \text{ ohm} \cdot \text{cm}$	12
1, 9, 4, 10-Antradiopyrimidine	8.8x10 ²⁴	15	3.22	$\rho_o = 1.3 \times 10^{-3}$	191
Anthranilic acid	2x10 ¹⁵	72	3.38	m.p. 146°C	91
Anthrone	8x10 ¹⁴	91	1.2	$\rho_o = 2.1 \times 10^5 \text{ ohm} \cdot \text{cm}$, discontinuity in ρ at 91°C	204
1, 2-Benzacridine	10 ¹⁷	30	2.10		63
2, 3-Benzacridine	10 ¹⁷	30	...		77
3, 4-Benzacridine	10 ¹⁵	30	...		77
					77

Substance	ρ ohm. cm	Temp °C	E_{in} $E/2kT$	Sign of Major- ity Carrier	Ref.
Benzanil	10 ¹³	20 to 50	5.6		176
1,2-Benzanthracene	10 ¹⁶	30	2.8		77
Benzanthrone	1.6×10^{16} to 4.3×10^{15}		2.7 to 3.42		70
Benzene	10 ¹⁵	5 to -14	0.84 ± 0.08		142
Benzimidazole	5×10^3	84 to 144	3.0 to 4.0		Ref. 259: dipole moment=4.03 D
		84 to 27	1.9 to 2.3		191
	10 ¹⁵	25	3.0-4.0		
Benzophenone	10 ¹¹	12.7	3.34		194
	3×10^{13}	-7	3.34		
Biphenyl	1.7×10^{15}	50	2.92		
Carbazole	2.5×10^{15}	50	1.172		
o-Chloranil	10 ¹⁵		3.0		79
Chloropromazine (single crystal)	10^{12} at 32°	32 to 80	2.1		142
	10 ¹⁵	> 47	2.0		186
	2.6×10^{11}				142
Chlorpromazine-free radical					84, 147
Circumanthracene (single crystal) (film)	6×10^2		1.8		84, 187
	10^{16} - 10^{17}		1.7		
Coronene	1.7×10^7	15	1.7		188
Cyamelurine	10^6 - 10^9			m. p. 438-40°C	188
Cyananthrone	1.2×10^7	30 to 125	0.20		198
1,6-Diaminopyrene	10 ⁸		0.6	$\rho_o = 10^5$ ohm. cm	278
					191
					278

Substance	ρ ohm. cm	Temp °C	E_{12} $E/2kT$	Sign of Major- ity Carrier	Ref.
Dibenzofuran	7.75×10^{14}	50	0.890	m.p. 86-7°C	79
Dibenzothiophene	1.0×10^{15}	50	1.712	m.p. 332-3°C	79
Dibenzo-(a, h)phrene-7, 14-dione	1×10^4			ρ vs pressure	24
Dibenzo-(cd, jk)pyrene- 6, 12-dione	2×10^4			ρ vs pressure	24
2, 3-dichloro-5, 6-dicyanobenzo- quinone	5×10^8	25	0.6	decomposes: 214-150°C	277
Flavanthrone	1.4×10^{11} 1.25×10^{11}	30 to 125 30 to 125	0.70 0.70	ref. 191: $\rho_0 = 10^5$ ohm. cm	191 57
9-Fluorene(Fluorenone)	3×10^{15}	50	5.40	m.p. 83°C	63
Fluorescein	1014	84	2.44	decomposes: 314-6°C	204
Fluoridine	6×10^3 4×10^{15} 2.5×10^{13}	20 to 140 20 to 140 20 to 140	1.6 1. p. 95	+	189 189 189
Hexacene	3.8×10^{10}	50	1.14 to 1.3		12, 79
Hexamethylbenzene	1018	20 to 140	1.78	+	190
Hydroviolanthrene	1.1×10^{25}	145 to 227	3.4		191
3-Hydroxy-n-methyl-phthalimide		60 to 91	3.80		142
Imidazole	7×10^{11}	30	2.6	m.p. 90°C; ref. 259: dipole moment 3.99 D	194, 286
Indanthrazine	1.4×10^{15}	30 to 125	0.66	$\rho_0 = 2.2 \times 10^9$ ohm. cm	191, 57

Substance	ρ ohm. cm.	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Indanthrone (black)	7.5×10^{14}	30 to 125	0.64		191
	2.5×10^8	30 to 125	0.56		191
	2.5×10^8	0.76		$\rho_o = 1.8 \times 10^{-1}$ ohm. cm	63
Meso-naphthodianthrone		40 to 450	1.48		160
		5 to 110	0.86		
		110 to 250	1.46		
		.74			
2-Methoxynaphthalene		42 to 58	6.5		192
Naphthacene				Ref. 248: heat of combustion (CP at 200°C) 2140.86 kcal/mole	
				Ref. 283: 6.95 e. v. ion. pot.	
				Heat of sublimation 29.7 kcal/mole	
				Ref. 41: work function 5.25	
				m. p. 335°C	
				76	
				12, 181	
Naphthalene				Ref. 249: lattice energy 17.3 kcal/mole	
				m. p. 80.22°C	
				Ref. 270 & 294: Ionization pot. =	
				8.08 e. v.; ref. 283: 7.53 e. v.	
				Ref. 244: $S_{298} = 39.9$ e. w.	
				$\Delta H_{298} = 15,960$ cal.	
				$\Delta S_{298} = -98.0$ e. w.	
				$\Delta G_{298} = +45,20$ cal.	
				193	
				1015 60 to 75 3.7	
				1019 20 to 75 1.4	
				1015 40 to 72 3.0	
				1015 40 to 80 1.46	
				1014 25 to 70 1.5	
				1014 27 to 47 3.5	
				2.25	
				142	
				265	

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity	Ref.
Naphthalene-picrate		48 to 96	2.2 to 2.6	m. p. 151.5°C	192
m-Naphthodianthrone	4×10^8	40 to 150	1.20		191
m-Naphthodianthrone	1.5×10^{18}	40 to 150	1.30	$\rho_o = 6 \times 10^6$ ohm·cm	191
meso-naphthodianthrone			0.74 & 0.43		267
β -Naphthol	2×10^5	60 to 110	2.36 ± 0.01	m. p. 122°C	90, 58
1-Naphthylamine	$10^{10} - 10^{13}$	25 to 42 20	2.2 to 2.9 1.8 to 2.8	m. p. 50°C $\rho_o = 5.6 \times 10^{-14}$ ohm·cm 7.6×10^{-8} ohm·cm	192 273
1-Naphthylamine picrate		28 to 98	2.7 to 2.9		192
2-Naphthylphenylsulfone		67 to 102	3.5 to 3.8		192
1-Nitronaphthalene		25 to 44	2.5 ± 0.1	m. p. 58.5°C	192
Octahydroviolaanthrene	1.1×10^{25}	1011	3.4		191
Octoido-p-benzquinhydron		2.3×10^{15} 2.3×10^{15}	40 to 125 1.13		62
Ovalene					191, 93 144, 180, 12, 196
Pentacene	1×10^{14}		1.5		77,
		0 to 150	1.62	m. p. high; b. ρ_o 290-300°C sub.	144
	6×10^{13}	20 to 140	1.5	Ref. 76: $\sigma = 10^{-2}$ ohm ⁻¹ cm ⁻¹	24, 76 265
				Unit cell a(7.90, 101.3); b(6.06, 111.8); c(15.95, 94.4)	79, 41
Perylene	4×10^8 10^{17} 1×10^{18}	15 60 to 80	2.0 1.96 2.0	m. p. 273-4°C $\rho_o = 1$ Ref. 270: Ionization pot. = 7.06 e.v.	198 76 142

Substance	ρ ohm.cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Perylene (continued)					
(single crystal)	10 ¹⁸	80 to 180	2.0		198, 93
(single crystal)	~ 10 ¹³	50 to 130	2.2		198, 93
(single crystal)	6.5x10 ¹⁵	40 to 100	↓(001)2.1		197, 77
(single crystal)	4.1x10 ¹³	40 to 100	↓(001)2.2		197, 77
			1.80		265
Phenanthrene	10 ¹³	27 to 90	2.82		Ref. 3: electron affinity ~ -1.3 142
(single crystal)	4.8x10 ¹⁵	12 to 72	↓(ab)1.14		Ref. 270: ionization pot. = 8.22 e.v.
(single crystal)	1.3x10 ¹⁴	12 to 72	(ab)1.15		Ref. 253: = 0.05 (PhCl = 1) 200
(single crystal)	5.4x10 ¹³				m.p. 101°C 200
					Ref. 244: $\Delta H_{298} = +23$, 100 cal 199
					$\Delta S_{298} = -123.7$ e.v.
					$\Delta G_{298} = +60.0$ kcal
See also:					3, 63,
					201,
					202
					203
2.24					Shows phase transition at 64-71°C 265
					Ref. 248: heat of combustion 298
					(CV at 200°C) 1, 684.88 kcal/g
Phenazine	7x10 ¹⁴	100	2.1		m.p. 171°C 37, 203
					Ref. 37: thermal activation energy 7
					at illuminated electrode 142
					0.17(-), 0.11(+) 235
1-Phenyl-naphthalene	1.7x10 ¹¹				m.p. ca. 45°C
Phenosafranine	10 ¹²	84	2.08		T vs σ , λ corresponding to E 204 is 595 m μ
Phenothiazine	10 ¹¹	50 to 150	1.6		Ref. 270: ionization pot. = 7.28 e.v.; 68, 203 m.p. 185.5°C

Substance	ρ ohm. cm	Temp $^{\circ}\text{C}$	E in $\text{E}/2kT$	Sign of Major- ity Carrier	Sign of Major- ity Carrier	Ref.
Phenylanthranilic acid	2×10^{15}	87 to 119	3.30			204, 260
Phosphonitrilic chloride trimer	$> 10^{15}$					142
	10^{15}		1.68			142
	8×10^{10}		0.7			205
Phthalocyanine, metal free	10^{13}	26 to 350	1.66	-	Mobility 0.1 to $0.4 \text{ cm}^2/\text{V} \cdot \text{sec}$	207
		-35 to 60	1 to 2		Ref. 254: $\text{PK in } \text{H}_2\text{SO}_4 = 1.65 \pm 0.02$	
		15 to 140	1.68	+	Mobility $4 \times 10^{-3} \text{ cm}^2/\text{V} \cdot \text{sec}$	206
		0 to 100	1.9		Does not melt	142
	10^{12} to					142
	10^{13}	60 to 110	1.7 ± 1		See ref. 142 for more references	208
			1.74			261
Phthalocyanine (metal-free α)	2×10^4	25	1.385		Seebeck coeff. $\approx -1.68 \text{ mV/}^{\circ}\text{C}$	285
	4×10^5	-60 to 135	0.48			209
(metal-free β)	2×10^{15}	200 to 315	1.82			209
(metal-free α)	2×10^{11}	20 to 100	1.32	+		142
(metal-free β)	5×10^{12}	25 to 165	0.81	+	Mobility 0.1 to $0.4 \text{ cm}^2/\text{V} \cdot \text{sec}$	207, 42
(single crystal)						
(metal-free β)	3.6×10^{17}	60 to 200	$\parallel (b) 1.82$			210
Pinocyanol	10^{12}		1.8		at 10^{-4} to $10^{-5} \text{ mm press.}$	219
Pyranthrene	1×10^{15}		1.44			12
	4.5×10^{16}	15	1.71		$\rho_0 = 2 \times 10^7$	57, 12, 145, 77
Pyranthrone	$3 \times 9 \times 10^{15}$	40 to 150	1.06; 1.8		m. p. : d. sub. vac.	56
					$\rho_0 = 3.7 \times 10^6$ ref. 56;	63
					1.3×10^{-1} ref. 63	

Substance	ρ ohm. cm	Temp °C	E in E/2kT	Major- ity Carrier	Sign of Major- ity Carrier	Ref.
Pyranthrone (continued)						
			1.5±0.05		See 24 for pressure effects no hysteresis with pressure E activation of photocurrent = 0.18 e.v.	144, 77, 24 266
10 ²⁰ 5x10 ¹⁷		60 to 90	2.4 2.02		Electron affinity +0.8 Ionization Potential 7.4 eV ref. 74, 283	80 76
10 ¹⁸		2.02			Ref. 181: 3.6x10 ⁻² photocurrent $\rho_0 = 1$ ohm·cm, $1E_1 = 3.70$ Ref. 247: heat of combustion CV at 25°, 9260. 1 cal/g Ref. 249: lattice energy 22.5 kcal/mole Ref. 255: relative electron absorption coef. (PhCl=1)= 6.0 m.p. 159-500°C	3, 12, 15, 22 76
5,6-N-pyridine-1,9- benzanthrone	8.5x10 ²²	15	3.20		$\rho_0 = 1.4x10^{-5}$ ohm·cm	191, 77 144
p-Quaterphenyl	1.0x10 ¹⁵	1.78			photoconduction thermal activation energy 0.12±0.015 eV m.p. 118°C	37, 77
Quaterrylene (single crystal)	10 ⁵ 10 ¹³	ab ab	0.6	-	Mobility 10 ⁻³ cm ² /V·sec Does not melt or decompose at 500°C	91, 272
Quinhydrone	10 ¹¹				m.p. 171°C	
α-Resoicin	2x10 ¹⁶	30 to 94	2.10			62

Substance	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
β -Resorcin	2×10^{18} 5×10^{18}	30 to 94 56 to 98	3.27 4.24		142 142
Salanil	10^4	20 to 40	4.1		92
Salen	10^{11}		5.7		92
Salphen	10^9		5.4		92
Stilbene	5×10^1		1.70	+	Mobility $2.4; 10^{-3}$ cm 2 /V.sec 45, 176
<u>cis</u> - Stilbene					Electron affinity ~ 0.0 Ref. 253: (PhCl = 1) = 1.0 3
trans - Stilbene		70 to 120	2.4		m. p. 124°C Electron affinity $\sim +0.5$ Ref. 253: 4.0 3, 77
m-Terphenyl				+	Mobility: 3×10^{-5} cm 2 /V.sec 142
p-Terphenyl (single crystal)	10^{14} 5×10^{14}	25 50	1.2 2.12	+	Mobility: 0.025 cm 2 /V.sec 37.77
Tetracene	8×10^9		1.70		Mobility: $\sim 10^{-5}$ cm 2 /V.sec 45, 142
					m. p. ca. 335°C Compressed at 100 kbar Ref. 23: a 7.98; b 6.14; c 13.57 24
Tetracyanoethylene	10^{12}	150			
1,1,10,10-Tetracyanodecapentaene	10^{13}	> 68	2.24		159
1,1,6,6-Tetracyanohexatriene	10^{14}		1.54		180

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
1, 1, 8, 8-Tetracyanotetraene	10 ¹²	1.42	-	-	180
1, 2, 4, 5-Tetraiodimidazole	10 ⁶	-	-	-	105
Tetrathiotetracene	10 ⁴	0.46	-	-	67
Thionine	10 ¹³ -10 ¹¹	49 to 97	1.83	-	204
Thiophenodioxazine	5x10 ¹⁴ 2x10 ¹⁶ 10 ¹⁵ -10 ¹⁶	20 to 140 20 to 140 20 to 140	1.65 1.7 1.7	-	142 142 142
2, 4, 7-Trinitrofluononone	10 ⁹ to 10 ¹²	-	-	ρ vs varying frequencies	58
Violanthrene	2. 1x10 ¹⁴ 10 ¹⁴ 2. 1x10 ¹⁴ 10 ¹⁴ 10 ⁹ 2. 3x10 ¹⁰	40 to 105 0.9 60 to 80 80 to 180 50 to 130 40 to 150	0.86 0.9 0.85 0.9 0.9 0.79	-	12 57, 93 198 198 198 56, 24
Violanthrone	5x10 ⁹	-	-	No hysteresis of ρ with T m. p. 490-50°C d.	57
Isoviolanthrene	3. 6x10 ¹⁴ 8. 4x10 ¹³	-	1.92 0.86 to 1.62	Ref. 24 gives ρ vs pressure $\rho_0 = 2. 9 \times 10^3$ $\rho_0 = 20 \text{ ohm} \cdot \text{cm}$	144 29
Isoviolanthrone	5. 7x10 ⁹ 5. 7x10 ⁹ 8. 5x10 ⁹ 3. 2x10 ¹⁹	40 to 150 40 to 150 50 to 130 50 to 130	0.75 0.76 0.96 1.76	Ref. 266: thermal emf $\sim 10^{-4} \text{ V}/\text{oC}$	56 93, 142 82 70

TABLE 2

COMPLEX METAL COMPOUNDS

Substance	ρ ohm-cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Co-dipyrromethene-1	1.4×10^{11}	> 159	1.88		173
Cu-dipyrromethene-1	1.0×10^{11}	> 112	1.85		173
Co-dipyrromethene-2	2.51×10^{11}	> 100	2.30		173
Cu-dipyrromethene-2	2.81×10^{11}	> 100	2.33		173
Ni-dipyrromethene-2	4.47×10^{11}	> 100	2.29		173
Zn-dipyrromethene-1	1.05×10^{14}	> 152	2.24		173
Dipyrromethene-1-hydriobromide	4.36×10^{13}	> 142	2.27		173
Ferrocene (single crystal)	1.2×10^{13}	20 to 80	0.6	+	
	10^{13}	150		Mobility: $1 \text{ cm}^2/\text{V} \cdot \text{sec}$	142
	8.6×10^6			Ref. 63: $\rho_0 = .65$, $E = 1.56 \text{ eV}$	
	1.78×10^7				159
	6.4×10^{12} to				231, 23
	2.56×10^{13}				239
			+	Mobility: $1.2 \text{ cm}^2/\text{V} \cdot \text{sec}$	296
				Thermoelec. power 1.2 A^2	
				Mobility: $2.2 \times 10^{-2} \text{ cm}^2/\text{V} \cdot \text{sec}$	142
				Ref. 77: $E = 1.6 \text{ eV}$	
Co-phthalocyanine (single crystal)	4×10^9			Ref. 41: work function 5.0	142
Cu-phthalocyanine	10^{12} to 10^{13}	-100 to 200	1.7	+	
	10^{12} to 10^{13}	60 to 160	2.4		261
	2×10^{11}			Ref. 254: ρK in $\text{H}_2\text{SO}_4 = 1.64 \pm 0.03$	142
	10^{12}	5 to 85	1.3		174
(single crystal)	10^{12} to 10^{13}	25 to 150	> 3700°K 1.66	Mobility = $75 \text{ cm}^2/\text{V} \cdot \text{sec}$	142,
			< 3700°K 2.0	See also 41, 77, 81, 144	271
			- 300°K		175
			+ 3700°K		175

Substance	? ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Fe-phthalocyanine	4x10 ⁹			Work function 4.85	41
Fe-tetracyanoethylene	3.3x10 ⁸			Dielec. const. E=7 at 3000 cycles/sec	268
Mg-phthalocyanine	10 ⁹ to 10 ¹⁰	60 to 180	0.5 to 0.8 1.56	Work function 4.75	41, 77 261
Mn-phthalocyanine (single crystal) 4x10 ⁶					174
Mo-phthalocyanine	~2x10 ⁹		1.1	$\rho_0 = 20$, ρ vs T given	63
Ni-phthalocyanine (single crystal) 6x10 ¹⁰				Ref. 77: E=1.6 eV	174
Pt-phthalocyanine			3.52	$\rho_0 = 4.4 \times 10^3$ ohm. cm	77
Zn-phthalocyanine (single crystal)	10 ¹² to 10 ¹³ 3x10 ⁹	-100 to 200 60 to 150	1.8±0.1 1.8±0.1	+ +	Ref. 254: pK in H ₂ SO ₄ =2.31±0.04 142 142 174
Ni (2) - Salen	10 ¹⁴		2.1		92
Cu (2) - Salen	> 10 ¹⁵				92
Ni (2) - Salphen	10 ¹⁵		3.4		92
Cu (2) - Salphen	> 10 ¹⁵				92
Sulfur compounds of aromatic hydrocarbons (structure unknown)	10 ² to 10 ⁴ 450	below	0.2		93
Cu-tetra-2, 3-pyridinoporphyrazine	2.9x10 ¹⁰ 3x10 ⁷	5 to 100	1.7 0.81 0.81	Ref. 271: E=1.17 eV	142
Tri-p-methoxyphenylmethyl- perchlorate (single crystal)	3.5x10 ⁹	18.5			142

Substance	ρ ohm cm	Temp °C	E in $E/2kT$	Major- ity Carrier	Ref.
Cs-1,3,6,8-tetrabromopyrene	1.6				109
Cs-1,3,6,8-tetrachloropyrene	8				109
Cs-1,3,6,8-tetracyanopyrene	6×10^5				109
Cs-1,3,6,8-tetranitropyrene	2×10^6				109
Cs-pyrene	2×10^6				109

TABLE 3

CHARGE TRANSFER COMPLEXES

Donor/Acceptor	ρ ohm·cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Acenaphthene/tetracyano- ethylene	5.3×10^{13}	20 to 85	2.04		66
Acridine/I ₂	10^{13}				62
Al-diethylchloride/pyridine	5×10^2				299
p-Aminodiphenylamine/ chloranil	10^{10}				62
Aniline/1, 3, 5-trinitrobenzene	1×10^{17}		2.54		113
p-Anisidine/chloranil	10^{11}				62
Anthracene/tetracyanoethylene	1.1×10^{10}	20 to 85	1.34		66
Anthracene/I ₂ vapor	10^{15-16}				142
Azulene/tetracyanoethylene	4.7×10^{10}	20 to 80	0.76		6,66
Benzidine/I ₂ (1:1)	2×10^6	-150 to -10	0.48		142
Benzidine/I ₂ (1:0.96)	2.5×10^9				264
Benzidine/I ₂ (0.75:1)	1.6×10^5	-70 to 20	0.68		Ref. 264: $\rho = 3.3 \times 10^5$ (1:1.35)
(1.00:1)	6.2×10^2		0.38		Ref. 264: $\rho = 3.3 \times 10^5$ (1:1.17)
(1.25:1)	2.2		0.38		Ref. 264: $\rho = 2.5 \times 10^5$ to 2×10^2
(1.50:1)	12		0.38		(1:1.50)
Benzidine/1, 3, 5-trinitrobenzene	3.3×10^8				264
Benzophenothiazine/I ₂	20		0.28 to 0.40		68
2:3-Benzoquilloline/1C1	10^{13}				62
3:4-Benzoquinoline/Br ₂	10^6		0.37	Series of isomers given pressure at 8-12 kg/cm ² leaves ρ unaffected	162

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	E in Carrier	Sign of Major- ity	Ref.
5,6-Benzoquinoline/Br ₂	3. 1x10 ⁷			1.70		162
7,8-Benzoquinoline/Br ₂	7.5x10 ⁶					162
1,2-Benzpyrene/tetracyano- quinodimethane	5x10 ¹¹			3.1		142
3,4-Benzpyrene/tetracyano- quinodimethane	4x10 ¹⁰		2.44			34
C ₆₀ /Pyrene	2. 1x10 ⁴			0.42		109
C ₆₀ /1,3,6,8-tetracholorpyrene	8			0.34		109
C ₆₀ /1,3,6,8-tetrabromopyrene	16			0.35		109
C ₆₀ /1,3,6,8-tetranitropyrene	2x10 ⁶			0.94		109
C ₆₀ /1,3,6,8-tetracyanopyrene	6x10 ⁵			0.70		109
Carbazole/chloranil	<10 ⁹					142
Carbazole/tetracyanoquino- methane	7x10 ¹⁰		10 to 127	1.1		142
Carbon/F ₂	0.059				69	-
β -Carotene/Tri-iodide	2x10 ⁸		-48 to 27	1. 1±0.1		163
p-Chloroaniline/1,3,5-trinitro- benzene	5x10 ¹³			2.72		166
Chloropromazine/melanine	1000					84
Cobaltocene/chloranil	2. 05x10 ⁴					73
Cobaltocene/2,3-dichloro- 5,6-dicyanocquinone (1:1)	3x10 ³			1.8		164

Pressure vs ρ data given

Donor/Acceptor	ρ ohm. cm	Temp °C	E in $E/2kT$	Sign of Major- ity	Ref.
Cobaltocene/3, 3', 5, 5'-tetra-chloro-p-diphenoquinone	40.1			Pressure vs ρ data given	73
Cobaltocene/tetracyanoethylene	10 ¹²		5.2		164
Cobaltocene/3, 3', 5, 5'-tetra-bromo-p-diphenoquinone	40.1			Pressure vs ρ data given	73
Coronene/I ₂	2×10^8 10 ⁹	25 to 70	0.5	+	Seebeck coeff. +1.7 V/°C 6, 86 62
Coronene/picric acid	10 ¹²				62
Coronene/1, 3, 5-trinitrobenzene	10 ¹³				
Coronene/2, 4, 7-trinitro-fluorone	10 ¹²				
Diaminodurene/chloranil (crystal)	$X7.0 \times 10^4$ Y _{6.9} $\times 10^4$ Z _{8.4} $\times 10^4$	-50 to 30	0.26	+	Seebeck coeff. +0.3±15% V/°C 61
(powder)	3×10^4	-50 to 30	0.29	+	61
1, 5-Diaminophthalene/chloranil (single crystal)	$X1.3 \times 10^9$ Y _{6.3} $\times 10^{11}$ Z _{2.0} $\times 10^{11}$	20 to 90	0.6	+	61
(powder)	7.2×10^{11} 6. 1 $\times 10^{10}$	20 to 90	0.74 0.65	+	61 61
1, 6-Diaminobenzene/2, 3-dichloro-5, 6-dicyanobenzquinone	10^6	25	0.37		277
1, 5-Diaminonaphthalene/1:1 chloranil	6.1×10^{10}				27, 26, 102
1, 6-Diaminopyrene/Br ₂	10^4	-72 to 23		Ref. 74: ~100% ionic	85

Donor/Acceptor	ρ ohm. cm	Temp °C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Sign of Major- ity Carrier	Ref.
1,6-Diaminopyrene/chloranil (single crystal)	$X10^9$		0.19			61
	$Y10^6$		0.19			
	$Z10^9$		0.19			
(powder)	4×10^3		0.15			
	10^4		0.30			
1,6-Diaminopyrene/(1:1) chloranil		1.2×10^4				
1,6-Diaminopyrene/ 2,3-dichloro-5,6- dicyanobenzoquinone		10^2				
3,8-Diaminopyrene/chloranil	4×10^3	25 to 70	0.15	$< 10^{-2}$	+	
3,8-Diaminopyrene/bromanil	1000	25 to 70	0.15	$< 10^{-2}$	+	
	1000	-70 to 80	0.12			
3,8-Diaminopyrene/dodanil	2×10^6	25 to 70	0.43 to 0.38			
3,10-Diaminopyrene/chloranil	3×10^6 to 1×10^7	25 to 70	0.39 to 0.41			
Dibenzo [c, d] -phenothiazine/ dichloro-5,6-dicyano- p-benzoquinone (2:1) (3:2)	20.7	27 to 127	0.42			
	230	27 to 120	0.44			

Donor/Acceptor	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Sign of Major- ity	Ref.
Dibenzo [c, d] -phenothiazine / 2, 3-dichloro-5, 6-dicyano-p-benzoquinone (2:1)	17	0 to 120	0.18	+ Carrier	Thermoelectric power + (about 100 μ V/C o)	2
	(2:1)	1.6			$P_0 = 5.6 \times 10^{-2}$ at 36 K bar	73
	(1:1)	5000	0 to 120			2
Dibenzo [c, d] -phenothiazine / 2, 3-dibromo-5, 6-dicyano-p-benzoquinone (1:1)	10^8	0 to 120		No. of free spins/g 1.6×10^{20}	No. of free spins/g 4.8×10^{20} at 36 K bar; press. vs ρ for 2 to 36 K bar	2
	230	27 to 127	0.44	ρ affected by absorbed moisture	No. of free spins/g 4.8×10^{20} at 36 K bar; press. vs ρ for 2 to 36 K bar	26
	(3:2)	240	0 to 120	0.27		73
	(3:2)	4.8		0.22		
Dimethoxybene/tetracyano-ethylene		1011				62
Dimethylaniline/chloranil		1.0 $\times 10^7$ $5 \sim 10^7$ ^3C	0.47			93
		8.1 $\times 10^8$ dc	20 to -45	0.47		152
		1.0 $\times 10^9$	15	0.47		62
Dimethylaniline/bromanil		1.7 $\times 10^9$ 9×10^7 ac	20 to -45	0.45		93
		1.5 $\times 10^9$ dc		0.45		152
Dimethylaniline/iodanil		1.9 $\times 10^8$ 3×10^7 ac	0.43			93
		1.7 $\times 10^8$ dc	20 to -45	0.43		152
N, N-Dimethylaniline / 1, 3, 5-trinitrobenzene		1×10^6	2.08	ref. 62: $\rho = 10^8$ single crystal	63, 166 142	

Donor/Acceptor	ρ ohm. cm	Temp °C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
Durenediamine/chloranil	1.80×10^{-15}		0.475			
N-Ethylcarbazole/Tetra- cyanoquinodimethane (1:1)	$~8 \times 10^{-13}$	10 to 127	1.1			ref. 73: $\rho = 8.4 \times 10^{-4}$, $\rho_0 = 9.39 \times 10^{-1}$
Ferrocene/2, 3-dichloro-5, 6- dicyanoquinone (1:1)	3×10^{-10}		1.4			142
Ferrocene/tetracyanoethylene	3×10^{-12}					164
	10^9					164
Graphite/Br ₂	10^{-4}	25 to -196		+		142
	2.6 to					87
	4.5×10^{-3}					+
(fully brominated)	6.3×10^{-6}					69
Hexamethylbenzene/chloranil	10^{11}					142
Hexamethylbenzene/tetra- cyanoethylene	4.1×10^{-13}	20 to 85	-. 16			62
1-Hydroxy-anthraquinone/ 1,8-naphthalic anhydride	3.05×10^{-5}					66
Li / anthracene (1. 16:1)	10^{11}	25 to 50	1. 34			62
	2.2×10^{11}		2.72			142
Lumiflavin/hydroquinone	2×10^{10}					212
Methylamine/chloranil	10^{14}	10 to 70	58 to 1. 02			142
N-Methylphenothiazine/I ₂	1. 4	20	0. 28			68
Naphtholene/tetracyano- ethylene	3.2×10^{15}	2.0 to 85	2. 48			6, 66, 113
β -Naphthol/2, 4, 7- trinitrofluorenone	10^{13} to 10^{18}		1. 8			58
						ρ vs varying frequencies

Donor/Acceptor	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Sign of Major- ity Carrier
α -Naphthylamine/1, 3, 5-trinitrobenzene	3×10^7	20 to 85	2. 48		Ref. 6, 66, 113
1, 5-Naphthlenediamine/I ₂	(0. 75:1) (1. 00:1) (1. 25:1) (1. 50:1)	6. 1x10 ⁷ 1. 6x10 ⁶ 1. 0x10 ⁶ 3. 1x10 ⁵	1. 32 0. 84 0. 80 0. 64		101
Pantanethylbenzene/ tetracyanoethylene	4. 4x10 ¹³	20 to 85	1. 12		66
Perylene/Benzoquinone	3×10^6		0. 9		167, 168
Perylene/Br ₂	7. 8	-20 to -170	0. 13	ref. 78: ρ_0 = 1 ohm cm	108, 106, 78, 93
Perylene/chloranil	$2. 8 \times 10^{11}$				27, 26, 102
(single crystal)	3×10^{14}		0. 73		142
Perylene/fluoranil mean	6×10^{13}		0. 73		142
Single crystal { c { c { c compacted 1:1	$8. 5 \times 10^{13}$ 2x10 ¹⁴ 6. 6x10 ¹³ 2x $2. 4 \times 10^{12}$		1. 46 1. 46 1. 46 0. 06		142 142 142 102
Perylene/I ₂	(1:1) (1:1)	10 8	-70 to 20 -180 to 25	< 0. 01	ref. 232: spin concentration (ESR) @ 3000K = 4. 6x10 ¹⁹
	(1:3) (2:3)	6. 3 3. 0-8. 0		Ref. 100: $X_M = -342 \times 10^{-6}$ Ref. 100: $X_M = -217 \times 10^{-6}$	31 for 2 Perylene·3 I ₂ complex stable in closed container
	(1:1)	2 to 3	25 to 70	$0. 011 \text{ to } 0. 019$	$< 8 \times 10^{-3}$ see also: 6, 66, 62, 59, 232
					86

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Sign of Major- ity Carrier	Ref.
Perylene/metal halides	10^5		0.5		+ or -	88
Perlene/Sb Cl ₅	32	-73 to +20	0.196			60
Perylene/tetracyanoethylene (single crystal)	2.4×10^{12}	20 to 85	1.44			
				ref. 6: molecular structure apparently 6,66, changed with pressure		
Perlene/I Cl	10^5	7 to 40	0.34			
Perylene/Pt Cl ₄	10^7 to 10^9	7 to 40	1.0			
Perylene/Sb Cl ₅	625	7 to 40	0.34			
Perylene/Sb Cl ₃	3.6×10^9	7 to 40	1.06			
Perylene/tetracyanoethylene	10^{14}	7 to 40				
Perylene/I ₂	125	7 to 40	0.2			
Perylene/2,3-dichloro-5,6-dicyanobenzoquinone	3×10^6	25	0.45			
Perylene/Fe Cl ₂	7.7×10^5	7 to 40	0.5			
Perylene/Fe Cl ₃	8.3×10^6	7 to 40	0.66			
Perylene/Os Cl ₃	5.9×10^{10}	7 to 40	1.2			
Phenanthrene/tetracyano- ethylene	2.2×10^{12}	20 to 85	1.52			
Penanthrene/1,3,5-trinitro- benzene	7×10^{18}		2.48			
				ref. 6: molecular structure apparently 113 changed with pressure		
				Seebeck coeff. +0.015 V/°C	114, 142	
				Seebeck coeff. +0.04 V/°C	114, 142	
				Seebeck coeff. +0.035 V/°C	114, 142	
				-0.01 V/°C		
				Decomposes 204°	277	

Donor/Acceptor	ρ ohm·cm	Temp °C	E in $\text{E}/2kT$	Mobility $\text{cm}^2/\text{V} \cdot \text{sec}$	Sign of Major- ity Carrier	Ref.
Phenazine/o-hydroquinone	7×10^{12}		0.5			142
Phenazine/dehydrophenazine	3.7×10^{10}		1.3 to 1.5			142
Phenazinium chloride/ pyrene	6×10^{10}		1.2			142
Phenazinium chloride/ p-hydroquinone	3×10^{11}		1.1 to 1.5			142
Phenazinium methosulfate/ pyrene	1.5×10^{13}		2.8			142
Phenazinium methosulfate/ p-hydroquinone	2.9×10^{12}		3.7			142
Phenothiazine/l ₂	20		0.34			68
Phenothiazine/l ₂ (recrystallized)	20		0.28 to 0.40			68
m-Phenylenediamine/ chloranil (5:3)	5×10^8	-90 to 50	1.17			142
p-Phenylenediamine/ chloranil (1:1)	2×10^7	15 to 100	0.86		see also ref. 1, 27, +	142
	5×10^6		0.570		167, 170 ref. 170: Seebeck coeff. 1.1×10^{-3} V deg ⁻¹ °C	
					Thermal conductiv- ity 2.0×10^{-7} w cm ⁻¹ deg ⁻¹ °C	
					62	
p-Phenylenediamine/benzo- quinone	10^6		0.74			167
Phenylenediamine/chloranil	6×10^6 to 1×10^8	25 to 70	0.57 to 0.65			+
						86

Donor/Acceptor	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
p-Phenylenediamine/chloranil	5×10^5	-10 to 20	0.5			1, 169
	6×10^6	25	1.67			86
	5×10^7	-23 to 57	1.14	Thermal cond. : 2.0×10^{-3} w./cm. °C	+	170
					Seebeck coeff. + 0.83 to 1.22 m V deg ⁻¹ °C	
	4.3×10^6					26, 27,
						102
						6
p-Phenylenediamine/fluoranil	$\sim 10^9$					
p-Phenylenediamine/iodanil	10^{11}					62
p-Phenylenediamine/I ₂	10^5					295
(0.45:1)	5.3×10^3	25 to 85	1.60			115
(0.67:1)	3.5×10^7	25 to 85	1.22			115
(0.82:1)	1.7×10^5	25 to 85	0.82			115
(1.03:1)	2.7×10^5	25 to 85	0.88			115
(1.36:1)	1.04×10^6	25 to 85	0.96			115
(1.62:1)	5.4×10^6	25 to 85	1.18			115
(3:1)	2×10^{10}	27				6, 62
p-Phenylenediamine derivatives/I ₂	(1:1.2)	3	-20 to 90	0.086		107
p-Phenyldiamine / 1, 3, 5-trinitrobenzene			0.8×10^{16}	2.04		113, 142
Poly(4-vinyl) Pyridine/I ₂						
(2:1)	10^4	1.3				116
(3.3:1)	10^7					116
Phthalocyanine/chloranil	10^0	25 to -100	0.4	10^{-4}	+	Seebeck coeff. + 0.130 m V deg ⁻¹ °C 117
K / anthracene	10^{11}	25 to 50	2.20			$\rho_o = 2.2 \times 10^4$ 165

Donor/Acceptor	ρ ohm. cm	Temp °C	$E_{1/2}$ E/2k	Sign of Major- ity carrier	Ref.
K/ graphite	1.72 to 0.68x10 ⁻³	-	-	-	
K 1.42: Isoviolanthrene	2600	0.28			Ref. 252: $\Delta H_5 = 6.6$ kcal/C ₈ K,
4:05 :	100	0.166			11.92 kcal/C ₂₄ K
4:35 :	27	0.060			$\rho_o = 1.0 \times 10^{-3} 24$
Pyranthrene/Br ₂	220	-20 to -170	0.20		Ref. 78: $\rho_o = 3 \times 10^{-2}$ ohm.cm
					62, 93,
					108,
					106,
					78
Pyranthrene/I ₂	17	0.09			93
Pyrene/Benzoquinone	1013	1.8			167
Pyrene/chloranil	1016	0.73			142
Pyrene/Tetracyanoquino- dinemethane	1016	0.73			142
Pyrene/I ₂	75	-18 to -70	0.136		Mobility: 0.01 cm ² /V.sec
	77	15	0.14-0.28		31, 62
					35, 66
Pyrene/Tetracyanoethylene	4.5x1015	20 to 85	1.65	+	Mobility: $\mu_- = 10^{-2}$ cm ² /V.sec
Pyrene/2, 3-dichloro-5, 6- dicyanobenzoquinone	1013	25	0.9		$\mu_+ = 30$
Pyrene/1, 3, 5-trinitrobenzene	1x1020		2.20		171
Riboflavin/hydroquinone	1x10 ⁶				277
					Decomposes 233-40°C
					113,
					142
					212
					1x10 ⁸ ohm.cm after 30 hrs. electrolysis

Donor/Acceptor	ρ ohm-cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Riboflavin/resorcinol	1.5×10^8			ρ unchanged after 30 hrs. electrolysis	212
Na 1. 07/Acridine	1.2×10^6	293	3.98		162
Na/ Anthracene	$10^8 - 10^{10}$	25 to 50	0.63	Ratio 1.08 to 2.12:1 given with ρ values	165
Na 1.60/Ahthracene (Et_2O) 0.30	6.2×10^{10}	0.26			
Na/3, 4-benzoquinoline (1.5:1)	1010	0.35			166, 162
Na/5, 6-benzoquinoline (1.6:1)	1.4×10^{11}	2.36			162
Na/7, 8-benzoquinoline (1. 10:1)	4×10^{17}	4.30			162
Na/ Bromanil	$< 10^{10}$				74
Na/1soviolanthrene (0.31:1)	3.1×10^5	0.42	-		29, 70
(2.37:1)	61	0.092	-		29, 70
Tetramethylbenzidine/chloranil	2.3×10^7				26, 27,
Tetramethylbenzene/Br ₂ (1: 48)	1×10^6				102
Tetramethylbenzidine/fluoranil	2.8×10^{12}				264
Tetramethylbenzidine/I ₂ (1:135)	1.6×10^9				26, 27,
Tetramethyl-p-phenylene- diamine/chloranil	2.4×10^4	0.53			102
	1.3×10^4 ac				264
	2.0×10^4 dc	0 to 25	0.53		93, 6,
Tetramethyl-p-phenylene- diamine/bromanil	1.6×10^5	0.56			62
	4.2×10^4 ac				89
	1.3×10^5 dc	10 to 25	0.56		6, 93
					89

Donor/Acceptor	ρ ohm·cm	Temp °C	E_{in} $E/2kT$	Major- ity Carrier	Ref.	
Tetramethyl-p-phenylene-diamine/iodanil	1.8×10^6 1.1×10^5 ac 1.5×10^6 dc	15 -10 to -30	0.59 0.59		93 89	
Tetrathiotetracene/chloranil	2 to 4	0 to 120	0.20	+	67	
Tetrathiotetracene/o-chloranil				Thermoelectric power = 20 to $30 \mu V/^\circ C$		
(3:1)	5.6	20 to 120	0.24		26	
(3:1)	0.30	0.040		$\rho_0 = 4.0 \times 10^{-1}$, ρ vs P given for 2 to 36 Kbar	73	
Tetrathiotetracene/o-bromanil	6 to 8	0 to 120	0.20	+	67	
	1.8	27 to 120	0.24		26	
(3:1)	0.42	27	0.02	$\rho_0 = 2.4 \times 10^{-1}$; ρ vs P from 2 to 36 Kbar	73, 26	
Tetrathiotetracene/tetracyanethylene	15	0 to 120	0.20	+	67	
o-Toluidine/I ₂	(0.75:1) (1.00:1) (1.25:1) (1.50:1)	3500 290 29 91	0.54 0.48 0.36 0.36		101 101 101 101	
Triethylamine/chloranil	10/14	10 to 70	0.88 to 1.7		142	
Violanthrene/Br ₂	66	-20 to -170	0.20		93, 78	
Violanthrene/I ₂	(1:1) (1:1) (1:3.17) (1:1.90) (1:1.31)	45 45 127 18.0 24.0	-20 to -170 10 to 60 -180 to 15 -180 to 15 -180 to 15	0.15 0.14 0.25 0.14 0.16	93 93 Mobility: $1.7 \times 10^{-3} \text{ cm}^2/\text{V} \cdot \text{sec}$ " 2.7×10^{-3} " " 5.4×10^{-3} "	100 100 100

Donor/Acceptor	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Violanthrene/I ₂ (continued)					
(1:0.118)	2.2x10 ²	-180 to 15	0.18	+	
(1:1x10 ⁻²)	3.1x10 ⁵	15 to 90	0.45	+	
(1:3.6x10 ⁻³)	2.8x10 ⁷	15 to 90	0.45	+	
(1:3x10 ⁻⁴)	6x10 ⁸				
(1:5x10 ⁻⁴)	1.4x10 ⁹	15 to 65	0.44	+	
(nil)	2.0x10 ¹⁴	60 to 200	0.94	+	
					100
Violanthrene/tetracyanoethylene	5.2x10 ⁸	20 to 85	0.35		66
Violanthrene/1, 3, 5-trinitro- benzene	5x10 ¹³	1.14			113 142
Isoviolanthrene/AlCl ₃ (1:3.7)	2.6x10 ¹²	1.30			29, 70
(1:3.2)	36	0.22	-		29.70
Isoviolanthrene/TiCl ₄ (1:1.87)	3.0x10 ¹⁰	1.28			29
(1:1.29)	354	0.26	-		29, 70
Isoviolanthrene/ICl	4.5x10 ¹¹	1.24			29, 70
(1:1.90)	2.2x10 ⁸	0.94			29, 70
(1:3.73)	1.1x10 ⁹	0.98			29, 70
Isoviolanthrene/I ₂	(1:1.52)	580	0.22		Seebeck coeff. -0.3 V/°C 29, 70
Isoviolanthrene/Na	(1:2.37)	61	0.96		$P_o = 10$ Thermoelectric power $-10\mu V/°C$
	(1:0.31)	3.1x10 ⁵	0.42		$P_o = 2.6$ attacked by water and oxygen
Isoviolanthrene/K	(1:4.35)	27	0.060		$P_o = 8.9$ Thermoelectric power $-20\mu V/°C$
	(1:4.05)	100.0	0.166		$P_o = 3.7$ Thermoelectric power $-10\mu V/°C$
	(1:1.42)	2600	0.028		$P_o = 5.2$ Attacked by water and oxygen

TABLE 4

FREE RADICALS AND RADICAL SALTS

Substance*	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Banfield and Kenyon's Radical	10 ¹⁵	40 to 25	2.31		146, 77
Ba: (TCNQ) ₂	5x10 ⁷	0 to 25	0.90	+	Seebeck coeff. +1 to 1.5 mV/°C 30, 33
2-Bromopyridine (TCNQ) ₂	21.5 to 1115				257
(3-bromoquinolinium) ₂ (TCNQ) ₂	0.5				257
(C ₂ H ₅) ₃ NH (TCNQ) ₂	1000		0.1-0.3	-	119
C ₈ (TCNQ)	2x10 ³	0 to 25	0.36	+	30, 33
C ₈ (TCNQ) _{1.5}	10 ⁵			-	30, 33
C ₈ (TCNQ) ₃ (single crystal)	1000	0 to 25	0.60	Seebeck coeff. -1.1 mV/°C Mobility < 0.1 cm ² /V·sec	30, 33
	2.5x10 ⁴				
	2.5x10 ⁴				
C ₈ ₂ (TCNQ) ₃	1000		0.1-0.3	Seebeck coeff. -0.5 mV/°C	119
Cu (TCNQ)	100	0 to 25	0.32	-	Ref. 257: m. p. < 3000°C 30, 33
4-Cyano-N-methylquinolinium (TCNQ) ₂ (single crystal)	1,50 33	0 to 25	0.16		30, 33 30, 33
4-Cyano-N-methylquinolinium (TCNQ)	1.4x10 ⁵	0 to 25		Ref. 257: m. p. 196-80°C	30, 33
4-Cyano-N-methylquinolinium (TCNQ) ₂	50	0 to 25			30, 33
3,7-diamino-2,8-dimethyl- 5-phenylphenazinium (TCNQ) ₂				m. p. > 2300° decomposes	257

* (TCNQ) = 7, 7, 8, 8-Tetracyanoquinodimethane
(TCNQD) = 7, 7, 8, 8-Tetracyanoquinodimethane - Li salt

Substance*	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
3, 7-diamino-2, 8-dimethyl-5-phenylphenazinium (TCNQD)	6.4×10^6			m. p. = 185-210°C decomposes	257
Di minodurene (TCNQ) ₂	2	0 to 25	0.16		30, 33
1, 6-Diaminopyrene (TCNQ)	0.5	-72 to 23	0.28	+	Seebeck coeff. +0. 052 mV/°C 13
1, 6-Diaminopyrene Br ₂	10 ⁴				Seebeck coeff. +0. 052 mV/°C 13
5, 8-Dihydroxyquinolinium (TCNQ)	10	0.14	+		30, 33
	14				72
α, α' -diphenyl- β -picrylhydrazyl (DPPH)	1.3×10^{10} dc 20 to 100 1.5×10^8 ac	0.15 0.26		$\rho_o = 10^{-7}$ $\rho_o = 10^{-8}$	82, 147
DPPH	0.17×10^8 ac	0.263			82, 147
DPPH c-axis single x-axis crystal Thin film	4.6×10^{10} 2.6×10^{10} 10 ¹⁰	1.22 1.7 ev	-	Mobility < 1 cm ² /V.sec Surface-type cell	149, 150 151 304
Galvinoxyl (Copinger's radical)	10 ¹³	1.45			152
Fe (TCNQ) ₂ · 3H ₂ O	5 ⁴	0 to 25	0.48	+	30, 33
Li (TCNQ)	2×10^4	0 to 25	0.64	-	Seebeck coeff. -0. 6 to -1. 4 mV/°C 72
Mn(TCNQ) ₂ · 3H ₂ O	10 ⁵	0 to 25	0.32		30, 33
N-Methyl-2, 3-benzoquinolinium (TCNQ) ₂ (single crystal)	36		0.22	Ref. 257: m. p. = 170°C	120, 33
N-Methyl-3, 4-benzoquinolinium (TCNQ) ₂ (single crystal)	230		0.28		120, 33

* (TCNQ) = 7, 7, 8, 8-Tetracyanoquinodimethane
(TCNQD) = 7, 7, 8, 8-Tetracyanoquinodimethane - Li salt

Substance*	ρ ohm.cm	Temp °C	E in E/2kT	E in E/2kT	Sign of Major- ity Carrier	Ref.
N-Methyl-7,8-benzoquinolinium (TCNQ) ₂ (single crystal)	125		0.30			120, 33
N-Methylquinolinium (TCNQ) ₂	2 to 10 331.3	0 to 25	0.14			30, 33 257
N-Methylquinolinium(TCNQ) ₂ (single crystal)	0.01	0 to 25	0.14	-	Seebeck coeff. - 50 μ V/°C	30, 33
N-Methylquinolinium(TCNQ)	107					30, 33
N-Methylquinoxalinium(TCNQ)	62					257
N-Methyl-2-styrylpyridinium (TCNQ) ₂	6.6					257
N-methyl-2-styrylpyridinium (TCNQD)	3.7×10^7					257
Methyl derivative of (TCNQ)/ methyl phenazinium	3×10^6					257
Methyl derivative of (TCNQ)/ methyltriphenylarsonium	57					257
Mono(2,2'-bipyridine) copper (TCNQ) bis (TCNQD)	19					257
Mono(1,10-phenanthroline)copper 15 (II) (TCNQ) ₄						257
Mono(1,10-phenanthroline) copper(II) bis (TCNQD)	34					30, 33
Morpholinium (TCNQ) (single crystal)	10^9	0 to 25	0.64			

* (TCNQ) = 7,7,8,8-Tetracyanquinodimethane
(TCNQD) = 7,7,8,8-Tetracyanoquinodimethane - Li Salt

Substance*	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Phenazinium chloride-pyrene	6×10^{10}	20 to 50	1.2		153
Phenazinium complex salts	10^{11} to 10^{16}		0.5 to 3.7		153
Poly(N-vinylcarbazole)- (TCNQ)	10^{14} to 10^{16}		1.1 to 1.5		302
Poly(4-vinylpyridine)-TCNQ)	1.58×10^7	18°			303
K (TCNQ) ₂	> 100		> 0.2	-	119
K(TCNQ)	5×10^3 10^4	0 to 25 0 to 25	0.72 0.70	+ +	Seebeck coeff. +0. 9mV/oC 30, 33 30, 33
Pyridium pyridine (TCNQ) ₂	123.1				257
Pyridine (TCNQ) ₂	85				257
Quinoline · hydroquinoline	2.7×10^{14}				257
Quinolinium (TCNQ) ₂	< 100		< 0.1		119
Quinolinium (TCNQ) ₂ (single crystal)	0.01		< 0.02	m. p. 220° decomposing Seebeck coeff. -50 μ V/oC	30, 33, 54, 36, 72
Quinolinium (TCNQ) ₂	0.01		0.06	-	301
Quinolinium (TCNQ) ₂ (single crystal)	0.25 31.5	0	0.06	Mobility < 0.02 cm ² /V. sec	30, 33 257
Quinolinium/acetylethylamine (TCNQ) ₂	0.01	0 to 25	0.06		30, 33 257

* (TCNQ) = 7, 7, 8, 8-Tetracyanoquinodimethane

Substance*	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Quinolinium/2-bromopyridine (TCNQ) ₂	49.8				257
Quinolinium/2-chloropyridine (TCNQ) ₂	9.0				257
Quinolinium/pyridine(TCNQ) ₂	12.7				257
Ag (TCNQ)	2×10^4	0 to 25	0.74	-	30, 33
Na (TCNQ)	10^5	0 to 25	0.66		30, 33
Tributylamine (TCNQ) ₂	8.2 to 10				257
Triethylammonium(TCNQ) ₂ (2:1)	109				30, 33
Triethylammonium(TCNQ) ₂	20				257
Triethylammonium (TCNQ) ₂ (single crystal)	0.25 25 1000	0 to 25	0.28	-	30, 33 54
Trimethylammonium(TCNQ) ₂ (2:1)	5×10^6	0 to 25	0.86	Ref. 257: m. p. = 245°C	30, 33
Triphenylnethylphosphonium (TCNQ) ₂ (single crystal)	50 500 10^5	0 to 25	0.60	Seebeck coeff. -0.10 mv/°C Mobility 0.04 cm ² /V. sec ref. 54: ~ 1% free radicals	30, 33 54
Triphenylnethylphosphonium (TCNQ) (single crystal)	5×10^{10}			Ref. 257: m. p. = 245°C	30, 33
Triphenylnethylphosphonium (TCNQ) ₂ (single crystal)	50 500 10^5	0 to 25	0.60	Seebeck coeff. +11mV/°C ref. 54: ~ 0.1% free radicals no photoconductivity	30, 33 54

* (TCNQ) = 7,7,8,8-Tetracyanoquinodimethane

Substance*	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
2,4,6-Triphenylpyridium (TCNQ) ₂	10		0.08		30, 33
Tris (2,2'-bipyridine) nickel (II)-bis-(TCNQD)	10 ⁵				257
Tris (2,2'-bipyridine) nickel (II)-bis-(TCNQD) ₂ -bis-(TCNQ)	2x10 ³				257
Tris (1,10-phenanthroline) cobalt (II) bis-(TCNQD)	10 ⁷				257
Tris (1,10-phenanthroline) cobalt 10 ⁴ (II) bis-(TCNQD) bis-(TCNQ)					257
Tris (1,10-phenanthroline) copper 10 ⁵ (II) bis-(TCNQD)					257
Tris (1,10-phenanthroline) copper 10 ⁴ (II) bis-(TCNQD)-bis-(TCNQ)					257
Tris (1,10-phenanthroline) manganese(II) bis-(TCNQD)	10 ³				257
Tris (1,10-phenanthroline) manganese (II) bis-(TCNQD)- bis-(TCNQ)	140				
Tris (1,10-phenanthroline) nickel 10 ⁴ (II) bis-(TCNQD)					257
Tris (1,10-phenanthroline) nickel 200 (II) bis-(TCNQD) - bis-(TCNQ)					257
Violanthene - B compound	7x10 ⁶	1.1x10 ¹¹	0.67 0.79		93

* (TCNQ) = 7,7,8,8-Tetracyanoquinodimethane
(TCNQD) = 7,7,8,8-Tetracyanoquinodimethane - Li salt

TABLE 5

POLYACENEQUINONE RADICAL POLYMERS

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{cm^2}{V \cdot sec}$	Sign of Majority Carrier	Ref.
7-Acenaphthol/1, 8-naphthalic anhydride	1.37×10^8	0.60				172
7-Acenaphthol/pyromellitic dianhydride	4.9×10^7	0.71				172
7-Acenaphthol/phthalic anhydride	4.2×10^7	0.58				172
Anthracene/phthalic anhydride (2:1)	9.5×10^7	25	0.698	$\rho_o = 70.8$		75
Anthracene/pyromellitic dianhydride	4.53×10^6			ρ vs load at 25°C and 105°C		25
Anthracene/terephthaloyl chloride (1:1)	1.3×10^8	25				75
Anthraquinone/pyromellitic anhydride (3:1)	2.0×10^4	25	0.382	$\rho_o = 8.90$		75
1, 4-Bisanthraquinonylaminonaphthaquinone/1, 8-naphthalic anhydride	2.7×10^6		0.472			172
1, 4-Bisanthraquinonylaminonaphthaquinone/pyromellitic dianhydride	1.5×10^7		0.515			172
1-Bromo-2-naphthol/1, 8-naphthalic anhydride	6.8×10^6		0.53			172
1-Bromo-2-naphthol/pyromellitic dianhydride	1.13×10^7		0.68			172
1-Bromo-2-naphthol/phthalic anhydride	4.6×10^6		0.62	+		172
6-Bromo-2-naphthol/1, 8-naphthalic anhydride	9.6×10^5		0.58			172
	2.9×10^6			0.571		172

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp °C	E in E/2kT	E in $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Sign of Major-ity Carrier	Ref.
6-Bromo-2-naphthol/pyromellitic dianhydride	$5 \cdot 9 \times 10^6$			0.66	172		
6-Bromo-2-naphthol/phthalic anhydride	$7 \cdot 2 \times 10^6$			0.58	172		
9-Bromophenanthrene/1,8-naphthalic anhydride	$5 \cdot 6 \times 10^6$			0.34	172		
2-Bromo-4-phenylphenol/1,8-naphthalic anhydride		$1 \cdot 0 \times 10^{11}$	1.20		172		
2-Bromo-4-phenylphenol/phthalic anhydride		$2 \cdot 3 \times 10^8$	0.62		172		
Carbazole/1,8-naphthalic anhydride		$2 \cdot 1 \times 10^8$	0.59		172		
Carbazole/phthalic anhydride β		$1 \cdot 9 \times 10^8$	0.54		172		
Dibenzanthrone (violanthrone)/pyromellitic dianhydride		$1 \cdot 9 \times 10^8$	0.43		172		
1,2-Dihydroxyanthraquinone/1,8-naphthalic anhydride		$7 \cdot 9 \times 10^7$	0.690		172		
1,2-Dihydroxyanthraquinone/1,8-naphthalic anhydride		$2 \cdot 1 \times 10^7$	0.68		172		
1,4-Dihydroxyanthraquinone/1,8-naphthalic anhydride		$1 \cdot 8 \times 10^7$	0.50		172		
1,4-Dihydroxyanthraquinone/pyromellitic dianhydride		$7 \cdot 0 \times 10^9$	0.570		172		
1,5-Dihydroxyanthraquinone/1,8-naphthalic anhydride		$3 \cdot 6 \times 10^5$	0.63		172		
1,5-Dihydroxyanthraquinone/pyromellitic dianhydride		$5 \cdot 2 \times 10^6$	0.703		172		
		$5 \cdot 8 \times 10^8$	0.845		172		
			+				

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{cm^2}{V \cdot sec}$	Sign of Major- ity Carrier	Ref.
1, 8-Dihydroxyanthraquinone/ 1, 8-naphthalic anhydride	2.8×10^5 2.2×10^7		0.52 0.766		+	172 172
1, 8-Dihydroxyanthraquinone/ pyromellitic dianhydride	9.2×10^7 2.3×10^8		0.67 0.563		+	172 172
1, 8-Dihydroxyanthraquinone/ tetraphenyl-1, 2-dihydro- phthalic anhydride	2.9×10^5		0.52			172
1, 4-Dihydroxynaphthalene/1, 8- naphthalic anhydride		10^{12}	1.11			172
1, 4-Dihydroxynaphthalene/ pyromellitic dianhydride	5.6×10^{11} 1.4×10^9		1.00			172
1, 4-Dihydroxynaphthalene/ phthalic anhydride	1.01×10^8		0.56			172
2, 3-Dihydroxynaphthalene/1, 8- naphthalic anhydride		9.4×10^7	0.58			172
2, 7-Dihydroxynaphthalene/ pyromellitic dianhydride	3.3×10^{10}		1.83			172
P, p'-Diphenol/phthalic anhydride		1.0×10^{12}				172
1, 4-Diphenylpiperazine/ phthalic anhydride		2.0×10^{12}				172
1-Hydroxyanthraquinone/1, 8- naphthalic anhydride	1.34×10^6 5.0×10^5		0.62 0.503		+	172 172
1-Hydroxyanthraquinone/ phthalic anhydride	6.0×10^6		0.58			172
1-Hydroxyanthraquinone/ pyromellitic dianhydride	7.0×10^5					172
Hydroquinone/phthalic anhydride	1.4×10^6		0.58			263

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp $^{\circ}$ C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Sign of Major-ity Carrier	Ref.
p-Naphthalobenzene/1, 8-naphthalic anhydride	1.0×10^{11}		0.68			172
p-Naphthalbenzein/phthalic anhydride	1.3×10^8		0.13			172
α -Naphthalphthalein/phthalic anhydride (2:1)	6.5×10^6	25	0.544			
Phenanthrene/acetic anhydride (2:1)	4.1×10^8	25				75
Phenanthrene/benzoic acid (1:1)	2.4×10^5	25	0.444			$\rho_o = 30.1$
Phenol/phthalic anhydride (4:3)	1.1×10^8	25	0.638			$\rho_o = 276$
Phenolphthalein/1, 8-naphthalic anhydride	6.4×10^6		0.77		+	172
Phenolphthalein/phthalic anhydride (2:1)	6.0×10^8		0.60			172
Phenolphthalein/pyromellitic dianhydride	8.8×10^7	25				75
Terephthaloyl chloride/naphthalene	5.3×10^9		0.65			172
1, 4, 9, 10-Tetrahydroxyanthracene/1, 8-naphthalic anhydride	6.0×10^{11}		0.956			$\rho_o = 251$
1, 4, 9, 10-Tetrahydroxyanthracene/phthalic anhydride	1.39×10^7					172
						172

	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{cm^2}{V \cdot sec}$	Sign of Major- ity Carrier	Ref.
Hydrocarbon/Acidic Derivatives						111
Polyacenequinone Radical copolymer pyrolyzed/ pyromellitic dianhydride	0.03	25 to 100	-0. 001		+	
Polyacenequinone radical Polymers prepared at 256°C	4.4×10^4 to 1.0×10^6		0. 516 to 0. 680			118
Pyrene/pyromellitic dianhydride	2.58×10^4	25				25
Terphenyl/pyromellitic dianhydride	7.7×10^6	25				
Triphenylchloromethane/ pyromellitic dianhydride	5.5×10^{13}	25				
				ρ vs load plot at different T		
				ρ vs load plot at different T		

Polymer Reactants	ρ ohm. cm	Temp °C	E_{in} $E/2kT$	Mobility $\frac{cm^2}{V \cdot sec}$	Mole Ratio	Catalyst	Ref.
Alizarin/pyromellitic anhydride	1.5×10^6	25	0.46	1.29×10^{-3}	1:1:1	ZnCl ₂	$\rho_o = 1.9 \times 10^2$ 55
Alizarin/pyrene/pyromellitic anhydride	1.3×10^4	25			2:2:2:3	ZnCl ₂	55
Amaranth/pyromellitic anhydride	5.8×10^8	25			1:1:1	ZnCl ₂	55
Amaranth/pyrene/pyromellitic anhydride	1.0×10^8	25			2:2:2:3	ZnCl ₂	55
Aniline black/pyromellitic anhydride	5.2×10^7	25	1.01	4.37×10^{-6}	1:1:1	ZnCl ₂	$\rho_o = 1.4 \times 10^{-1}$ 55
Aniline black/pyromellitic anhydride	1.4×10^6	25	0.11	1.52×10^{-6}	2:2:2:3	ZnCl ₂	$\rho_o = 1.5 \times 10^{-1}$ 55
Anthracene/pyromellitic anhydride	2.4×10^6	25			1:1:1	ZnCl ₂	55
Benzoaazurine G/pyromellitic anhydride	3.32×10^6		0.534×10^6				65
Benzoaazurine G/pyrene/pyromellitic anhydride	3.1×10^7	25			1:1:1	ZnCl ₂	55
Chrysen/pyromellitic anhydride	2.4×10^{10}	25			2:2:2:3	ZnCl ₂	55
Congo Red/pyromellitic anhydride	1.0×10^6	29	0.387			ZnCl ₂	65
Congo Red/pyromellitic anhydride	3.1×10^7	25			1:1:1	ZnCl ₂	55
Dibenzpyrene/pyromellitic anhydride	7.4×10^9	25			2:2:2:3	ZnCl ₂	55
Dibenzpyrene/pyromellitic anhydride	7.4×10^9	25			2:2:2:3	ZnCl ₂	65

Polymer Reactants	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Mole Ratio	Catalyst		Ref
2, 5-Dichloro-3, 6-dihydroxy-p-benzoquinone/pyromellitic anhydride	7.2×10^8	25	1.20	4.92	1:1:1	ZnCl ₂	$\rho_o = 5.1 \times 10^{-2}$	55
2, 5-dihydroxy-p-benzoquinone/ pyromellitic anhydride	5.4×10^8	25	0.95	2.54×10^{-5}	1:1:1	ZnCl ₂	$\rho_o = 4.8$	55
Eosine Y/pyromellitic anhydride	1.3×10^9	25			1:1:1	ZnCl ₂		55
Eosine Y/pyrene/pyromellitic anhydride	1.0×10^6	25	0.11	2.13×10^{-6}	2:2:2:3	ZnCl ₂	$\rho_o = 8.9 \times 10^1$	55
Ferrocene/salicylic acid	2.5×10^8	50	0.33		1:1:8	t-butyl peroxide		237
Fluorescein/pyromellitic anhydride	7.7×10^{10}	25			1:1:1	ZnCl ₂		55
Fluorescein/pyrene/pyromellitic anhydride	7.1×10^7	25	0.38	5.85×10^{-6}	2:2:2:3	ZnCl ₂	$\rho_o = 2.7 \times 10^1$	55
Indigo/pyromellitic anhydride	3.9×10^6	25			1:1:1	ZnCl ₂		55
Indigo/pyromellitic anhydride	1.5×10^5	25			2:2:2:3	ZnCl ₂		55
Meldola blue/pyromellitic anhydride	1.7×10^8	25	0.82	1.31×10^{-2}	1:1:1	ZnCl ₂	$\rho_o = 1.9 \times 10^1$	55
Meldola blue/pyrene/pyromellitic anhydride	6.8×10^6	25			2:2:2:3	ZnCl ₂		55
Naphthalene/pyromellitic anhydride	1.48×10^7	23	1.05			ZnCl ₂		65
Naphthalene/terephthaloyl chloride	6.0×10^{11}	25	0.956		1:1:1	ZnCl ₂	$\rho_o = 2.5 \times 10^2$	75

Polymer Reactants	ρ ohm. cm	Temp ° C	E in $E/2kT$	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Mole Ratio	Catalyst	Ref.
p-Naphtholbenzein/pyromellitic anhydride	3.3×10^8	25	1.02	3.22×10^{-1}	1:1:1	ZnCl ₂	$\rho_o = 7.8 \times 10^{-1}$ 55
p-Naphtholbenzein/pyrene/pyromellitic anhydride	7.5×10^5	25			2:2:2:3	ZnCl ₂	55
α -Naphthol-phthalic anhydride/phthalic anhydride	6.5×10^6	25	0.544		2:1:1	ZnCl ₂	$\rho_o = 1.05 \times 10^2$ 75
Perylene/pyromellitic anhydride	1.25×10^5	25	0.318			ZnCl ₂	65
Phenanthrene/benzoic acid	2.4×10^5	25	0.444		1:1:1	ZnCl ₂	75
Phenanthrene/pyromellitic anhydride	2.9×10^5	25	0.47	8.23×10^{-3}	1:1:1	ZnCl ₂	55
Phenol/phthalic anhydride	3.59×10^6	30	0.545			ZnCl ₂	65
Picene/pyromellitic anhydride	1.1×10^4	25	0.638		4:3:2	ZnCl ₂	$\rho_o = 2.67 \times 10^2$ 75
Pyrene/m-aminobenzoic acid	2.35×10^5	29	0.219			ZnCl ₂	65
Pyrene/1, 12-benzoperylene	4.7×10^2	25			1:1:1	ZnCl ₂	K_a (acid dissociation constant) = 55
Pyrene/chloroacetic acid	2.8×10^4	25			1:1:1	ZnCl ₂	1.51×10^{-5} 55
Pyrene/o-chlorobenzoic acid	5.9×10^2	25			1:1:1	ZnCl ₂	$K_a = 1.4 \times 10^{-3}$ 55
Pyrene/m-chlorobenzoic acid	7.3×10^2	25			1:1:1	ZnCl ₂	$K_a = 1.29 \times 10^{-3}$ 55
Pyrene/p-fluorobenzoic acid	1.3×10^3	25			1:1:1	ZnCl ₂	$K_a = 1.51 \times 10^{-4}$ 55
Pyrene/9-fluorene carboxylic acid	7.8×10^4	25			1:1:1	ZnCl ₂	$K_a = 7.22 \times 10^{-5}$ 55
Pyrene/gallic acid	9.8×10^{11}	25			1:1:1	ZnCl ₂	55
Pyrene/o-iodobenzoic acid	1.3×10^7	25			1:1:1	ZnCl ₂	$K_a = 1.25 \times 10^{-3}$ 55
Pyrene/p-nitrobenzoic acid	2.7×10^2	25			1:1:1	ZnCl ₂	$K_a = 3.98 \times 10^{-4}$ 55

Polymer Reac tants	ρ ohm. cm	Temp °C	E in $E/2kT$	E in $\frac{cm^2}{V \cdot sec}$	Mobility $\frac{cm^2}{V \cdot sec}$	Mole Ratio	Catalyst	Ref.
Pyrene/pyromellitic anhydride	3.9×10^5 3.82×10^5	25	0.10 0.42	4.50×10^{-6}	1:1:1	ZnCl ₂	55	
Pyrene/Pyrene/pyromellitic anhydride	5.6×10^3	25		2:2:2:3	ZnCl ₂		65	
Pyrene/syringic acid	2.2×10^7	25			1:1:1	ZnCl ₂	55	
Pyrene/X anthene-10-carboxylic acid	1.5×10^7	25	0.61	2.46×10^{-3}	1:1:1	ZnCl ₂	$\rho_o = 7.6 \times 10^{-1}$	
Pyromellitic anhydride/chloroacetic acid	4.00×10^2				ZnCl ₂		65	
Pyromellitic anhydride/quinizarin	8.2×10^5	25	0.41	4.53×10^{-8}	ZnCl ₂	$\rho_o = 5.2 \times 10^2$	55	
Pyromellitic anhydride/quinoxaline	5.6×10^6	25	0.80	5.58×10^{-7}	ZnCl ₂	$\rho_o = 9.2 \times 10^{-1}$	55	
Pyromellitic anhydride/terephenyl	1.05×10^8	25	0.820		ZnCl ₂		65	
Tetracene/phthalic anhydride	9.27×10^6 7.50×10^9	25	0.657		1:1:1	AlCl ₃	$\rho_o = 80.4$	
Tetracene/pyromellitic anhydride	3.95×10^5	25	0.557		1:1:1	AlCl ₃	32	
Violanthrone/pyromellitic anhydride	5.9×10^3	25	0.09	2.44×10^{-4}	1:1:1	ZnCl ₂	$\rho_o = 1.0 \times 10^3$	
Violanthrone/pyrene/pyromellitic anhydride	2.8×10^3	25	0.10	6.26×10^{-4}	1:1:1:1.5	ZnCl ₂	$\rho_o = 3.7 \times 10^2$	

TABLE 6

LONG CHAIN COMPOUNDS AND POLYMERS

Substance	ρ ohm·cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Acetylferrocene polymer	10 ⁷	50	0.31-0.47	ZnCl ₂ catalyst (1:1)	236
Anthracene polymer reactant	1.66x10 ⁸	25	0.771	$\rho_0 = 9.84 \times 10^2$, ZnCl ₂ catalyst	32
Benzothiadiazole	3.3x1011	25	2.6		71
Benzoselenodiazole	1.6x1014	25	2.8		71
2,2'-Bisbenzimidazole	1.6x1017	25	1.92		71
5,5'-Bibenzoselenodiazole	5x1016	25	1.54		71
1,3-Bis-(2-benzimidazolyl) benzene	1x1017	25	1.76		71
1,4-Bis(2-benzimidazolyl)benzene5x1016	25	1.56			71
β,β' -Bis-(2-benzimidazolyl)- 1,4-divinylbenzene	2.5x1013	25	1.18		71
Bromodihydropolycyclopentadiene 10 ⁶					154
Carbazole-tetralone polymer	7.5x10 ³				32
reactant					
Cu-Phthalocyanine polymers	20 to 100	27			284
Cu-imidazole polymer	>1015				142
Co-imidazole polymer	1017	114			286
1,5-Diformyl-2,6-dihydroxy- naphthalene oxime, metal polymers ⁶					
(Pd)	10 ⁶	-78 to 78	0.48		
(Cu)	10 ⁴ -10 ⁵		0.46		
(Ni)	10 ⁴ -10 ⁵		0.46		
				Mobility: high	
					95, 96

Substance	ρ ohm·cm	Temp °C	E_{in} $E/2kT$	Sign of Major- ity Carrier	Ref.
2, 5-dihydroxy-p-benzo- quinato Cu(II)	10^{10} dc 10^7 ac	100			28
1, 6-Dihydroxyphenazinato- Cu(II)	10^{13} dc 10^7 ac	60 to 160 2	2	No hysteresis with pressure	28
Diketopiperazine	1.3×10^{10}	2.19			142
Diphenylamine polymers	10^8 - 10^{10}	0.8 to 1.1			142
Ferrocene-acetone polymer	6.7×10^{14}	50	0.83	7-butyl peroxide catalyst	237
Ferrocene-benzal copolymer	10^7 - 10^8			121,	
				118	
Ferrocene, α -bromo-naphthaline polymer	4×10^{11} to 3.5×10^9	50	0.47 to 0.3	ρ vs various ratios of reactants	237
Ferrocene-carbonyl copolymer	10^3 - 10^{12}				118
Ferrocene, 1, 1'-diacetyl polymer	3.6×10^9	50	1.45 to 0.42		237
Ferrocene, 1, 1'-diacetyl polymer	10^5 to 10^{10}		0.05 to 0.4		237
Ferrocene, m-dichloro-benzene polymer	4×10^{11} to 3.5×10^9	50	0.47 to 0.3	ρ vs various ratios of reactants	237
Ferrocene polymers(polyketones)	10^3 - 10^{11}		> 0.9		99, 121,
Ferrocnyl acetate polymer	3.6×10^9	50			281
FeCl ₂ polymer of chloranil: o-phenylenediamine	$< 3.8 \times 10^{14}$	2.0 to 250			276
Furan, pyrrole	7.9×10^{10}	25	1.488	$\rho_O = 8.08 \times 10^{-2}$ ohm cm	110
					32

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Fumaronitrile, pyrolyzed	6.3×10^1		0.22		
Graphite	0.0285	15			284
Graphites, pyrolytic	500-3500	-13 to 800	0.09	+ or - f(temp)	$\Delta H_f^{\circ} = 0.00, \Delta G_f^{\circ} = 0.00, S^{\circ} = 1.3909,$ $C_P = 2.066 \text{ at } 25^{\circ}\text{C}$
Indole, tetralone polymer	8.80×10^3				69, 245
3-(4'-isopropylphenyl)-benzo- quinoline	1.4×10^{13}				32
Malonitrile polymer	1011	20			235
2-(2'-methyl-5'-isopropyl-phenyl) quinoline	3.2×10^9				236
1-methyl-2-picolinium polyiodide	10^7-10^{10}	20 to 100	1.5 to 2.2		235
1-methylquinolinium polyiodide	10^7-10^{10}	20 to 100	2	+	142
2- β -naphthylbenzimidazole	1.4×10^{15}	25			142
2-a-Naphthylbenzimidazole	2.5×10^{15}	25	1.32		71
2,2'-Di- β -naphthyl-5,5'- bibenzimidazole	2.5×10^{14}	25	1.44		71
			0.62		71
2,3-naphthoselenodiazole	2.5×10^7	25	2.0		
1,2-Naphthothiadiazole	3.3×10^{20}	25	8.0		71
2,3-Naphthothiadiazole	3.3×10^{13}	25	5.2		71
Naphthalene, polymer reactant	1.31×10^{11}				71
1,4-naphthazuinone, p-toluene dissocyanate polymer	1.19×10^{11}	23	2.00		32
					65

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Naphthylendiamine polymer	10 ¹⁰ -10 ¹³	20			273
Neoformazan	10 ¹³ to 10 ¹⁴		4.87		119, 63
Nylon (fully hydrated)	10 ⁸				142
Nylon 6-10	10 ⁸	400	2 to 4		155
Nylon 66 (theoretical value as single crystal)	8.4		2		
N-methylated nylon 10-10	1.5x10 ¹⁰	-20 to 60	2.5		
Pyrolyzed phenol formaldehyde cation exchanger with Na ⁺ Mg ²⁺ Al ³⁺ Metal-free	10 ⁻⁵ to 10 ⁻¹ 10 ⁸ to 10 ⁻² 10 ⁷ to 10 ⁻² 10 ⁸ to 10 ⁻²		+	+	123 123 123 123
Perylene-polymer	1.22x10 ⁷				32
Phenolphthalein polymer	4.7x10 ⁸	25			75
3-Phenyl-benzo-quinoline			8.7x10 ¹²		235
1-Phenyl-2-butyl-naphthalene			3.5x10 ¹²		235
1-Phenyl-2-dodecyl-naphthalene			2.7x10 ¹²		235
2-phenyl-5-methylbenzimidazole	5x10 ¹⁵	25	2.46		71
Phosphonitrile chloride trimer	10 ¹³ -10 ¹⁵				276
Phthalocyanine polymers	> 1000		0.6		124
					284

Substance	ρ ohm·cm 10^9	Temp $^{\circ}\text{C}$	E in $E/2kT$	E in V. sec	Sign of Major- ity Carrier	Ref.
Polyacenaphthylene: tetra-cyanoethylene; atactic	10^4 to 10^{10}	60 to 280	0.26 to 1.8	+	Mobility: $10^{-2} \text{ cm}^2/\text{V. sec}$	121
Polyacetylenes	8.1×10^{11}	50	0.67			237
Polyacetylene	4.2×10^5		0.46			97
Polyacetylene	3×10^{13}					142
Polyacetylenes, crystalline	10^5 to 10^8 1.4×10^4		0.45 0.46			97
Polyacetylene, amorphous	10^9 to 10^{12}		0.46			97
Polyacrylonitrile	5×10^8	400	0.64			263
Polyacrylonitrile, pyropolymer, CuCl_2 -impregnated	100	300				125
Polyacrylonitrile pyrccopolymer	10^{13}	28 to 120 120 to 169	1.2 1.8			142
Polyacrylonitrile, pyrolyzed	1.30 mean	-65 to 140	0.21 mean	-	Mobility: $< 1 \times 10^{-2} \text{ cm}^2/\text{V. sec}$	127
	range to 10^{12}					126
Polyamides (nylon)	10^8 to 10^{10}	400	2 to 3			142
Polyanthracene	8.3×10^5		0.26			111
Polyazochlorphenylene	10^{14}	50 to 110	5.2			156
Polyazofluorine	1.3×10^{12}	50 to 110	3.6			142
Polyazomethoxyphenylene	7×10^{13}	50 to 110	2.4			156
Polyazonitrophenylene	2×10^{14}	50 to 110	5.0			156

Substance	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Polyazophenylenes	1 to 2. 5×10^2	120 to 150	1.24 to 1.92		128, 129
Polyazophenylene	5 $\times 10^{11}$	50 to 110	3.6		156
Poly(azophenylether)	2 $\times 10^{14}$	50 to 110	4.4		156
Poly (azophenyl sulfide)	10 ¹⁵	50 to 110	5.2		156
Poly (azophenyl sulfone)	1.5 $\times 10^{14}$	50 to 110	4.4		156
Polyazostilbene	2.5 $\times 10^{13}$	50 to 110	3.6		156
Polybenzenes from hexachloro- benzene	0.2 to 25				104
Polybenzenes from trichloro- benzene	10^3 - 10^4				104
Polybenzimidazoles	4 $\times 10^{10}$ to 10 ¹⁶ at 1800 atm		1.12 to 2.23 at 1800 atm		75, 138, 157
Polybutadiene (glow-discharge polymerized)	10 ¹² to 10 ¹⁵		0.29 to 1.8		142
Poly-Cu-phthalocyanine	40	25 to 300	0.26	+	Ref. 287: $P = 3.8 \times 10^{-1}$ Mobility: 10 cm ² /V. sec
Poly-Cu-phthalocyanine, heat treated	4	50 to 400	0.12	+	Ref. 287: $P = 1.35 \times 10^{-2}$ Mobility: 2.5 cm ² /V. sec
Poly-Cu-tetracyanoethylene	3.0		0.12		287
Polydehydrocondensation products of bis-acetylenes	10 ¹⁴	20 to 800	1.2 to 1.8		158
Polydibenzpyrrene	950	25 to 100	0.206	-	111
Polydiketone	10 ⁴				118

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Polyethylene DFD 4400	5×10^{18}		3.05		234
Polyethylene β -irradiated: pyrolyzed	10 ⁹		0.64	+	142
Polyethylene β -irradiated: complex with I ₂	2500		0.02		130
Polyimidazoles, pyrolyzed	2				105
Polyisobutyl ferrocenylene	2.7×10^{11}	50	0.45		237
Polymer carbon Ni doped (pyrolyzed ion exchange resins)	0.348 to 0.00418	98 to -55	0.065 to 0		131, 132
Polymer, N-substituted dithiocarbamate	$\geq 1.5 \times 10^{10}$	17 to 152	0.36 to 0.72		142
Polymer, dithioxamade (Co) (Cu) (Ni)	10 ¹⁵ 2.5×10^7 5×10^{10}	127 to 227 17 to 77 17 to 227	0.7 0.6 0.6		142 142 142
Polymeric phthalocyanines		10 ⁷ to 10 ¹¹			142
Polymers, thiocyanate	$\sim 10^{12}$		0.58 to 0.76		142
Polymer, thiophene	10 ¹⁵		1.2		159
Polymer, thioacetamide	10 ¹⁵	25 to 175	2.0		159
Polymer, pyrrole	10 ¹⁵		1.3		159
Polymer, pyrazole	10 ¹⁴		1.4		159
Polymeric condensation product of phthalic anhydride and hydroquinone	10^5 to 10 ⁶		0.6 to 0.8		133

Substance	ρ ohm·cm	Temp °C	E in $E/2kT$	Sign of Major- ity	Ref.
Polymeric product of tetra-cyanoethylene with metals or metal compounds at 160 to 300°C	100		0.21 to 0.26		134
Polymeric Schiff bases	10^7 to 10^{11}	25			
Polynaphthalene	9.7×10^6	25 to 100	0.32	+	
Poly [N-N'-(p-p'-oxidiphenylene) pyromellitimide]	0.05		2.2 ± 0.26		
Polypentyne -1	3×10^9	10-15			
Polyphenanthrene	10^5		0.2	+	
Polyphenyl	10^{10} to 10^{11}				
Polyphenylacetylene	4.8×10^{10}	25	0.432		
Polyphenylene	10^{11} $> 10^{15}$	25 to 90			
Poly-p-phenylene	$> 10^{15}$				
Poly-p-phenylene- iodide	2.5×10^4		0.87		
Polypropyne	10^{11}		0.65		
Polyphenyltriazine	6.2		0.72		
Polypprene	10^4	25 to 100	0.16 to 0.2	+	
Polypyridines, substituted	0.03 to 15				

Substance	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Poly- β -pyridylacetylene	10 12 - 10 13	25	2.50		79
Poly (quinone imines)	2.5x10 ⁵				290
Poly-Schiff bases (p-pyenylenediamine-benzyl polycondensate)	3x10 ¹¹	21 to 75 90-115 60-90	2.8 1.08 0.45	$\rho_o = 1.2 \times 10^3$ $\rho_o = 2.5 \times 10^7$	290 274
Polystyrene (tablet)	5x10 ³		1.3		262
Polystyrene-AgClO ₄ atactic	4x10 ⁸		1.48		120, 34
Polystyrol	10 ⁹	20 to 60	0.8		83
Polysulfur-anthracene	330				104
Polysulfur nitride	0.6167 to 0 0.0394		< 0.04		136
Polyterephthalonitrile	2. 1x10 ¹⁰		0.622	$\rho_o = 4.20 \times 10^4$ ohm cm	59
Polytetrachlorophenyl-thioether	1 to 10 ⁷				119, 121
Polytetrachlorothiophenol	3. 38x10 ⁶				65
Polytetracyanoethylene-Cu film	10(highest)		0.1 to 0.5		297
Poly-s-triazine			1. 081	$\rho_o = 1.25 \times 10^4$ heating cycle; $\rho_o = 5.22 \times 10^2$ cooling cycle	59
Polytriphenylmethane	5. 8x10 ¹¹	25 to 100	0.42		142
Polyvinylalcohol, pyrolyzed	10 ⁵ to 10 ¹³		0. 3 to 0.5		137
Polyvinylalcohol: metal chelates	> 10 ¹³		1. 2 to 3. 3		137
Polyvinylanthracene: 9-Vinyl	10 ¹⁵		1.59		142

Substance	ρ ohm. cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Polyvinylanthracene: 9-Vinyl/I ₂ (1:7)	2. 1x10 ⁶		1.02		
Polyvinylanthracene: 9-Vinyl/I ₂ (1:2.8)	3. 7x10 ⁶		1.03		142
Polyvinylanthracene-Iodine	10 ⁵ at 57000 atm	38 to 80	0.8		142
Polyvinylanthracene-I₂ complex (polymer)	3. 1 to 7. 9x10 ⁴ at 57000 atm				139
Polyvinylcarbazole	10 ¹⁷	10 to 127			
Poly (N-vinyl) carbazole: Tetracyanoquinodimethane	10 ¹⁴ -10 ¹⁶	10 to 127	1.1-1.5		
Polyvinylchloride, pyrolyzed	>> 10 ⁵				
Polyvinylchloride (chlorinated), pyrolyzed	1. 4x10 ⁷ >> 10 ⁵		0.4		
Polyvinylene	10 ¹¹	25 to 90			142
Polyvinylene	10 ⁷	25 to 90	1.06		116
Polyvinylmethylene	10 ¹³				116
Poly-N-vinyl-5-methyl-2- oxazolidinone	> 10 ¹⁴				120, 34
Poly-N-vinyl-5-methyl-2- oxazolidinone complexed with resorcinol	10 ¹⁴				118

Substance	ρ ohm·cm	Temp °C	E_{in} $E/2kT$	Sign of Major- ity Carrier	Ref.
Poly-N-vinyl-5-methyl-2-oxazolidinone complexed with p-quinone	10^{14}				118
complexed with Iodine	4.5×10^6				118
Polyvinylnaphthalene	10^{13}				120
Polyvinylnaphthalene-2, 3-dichloro-5, 6-dicyano-p-benzoquinone	10^{13}				120
Polyvinylnaphthalene-tetracyano-ethylene	3×10^4	1.20	+		120
Poly(2-vinylpyridine)-I ₂ complex (5:3)	10^4				116
Poly(4-vinyl)pyridine:I ₂	10^4				116
Polyvinylpyridinium: tetra-cyanoquinodimethane derivatives	$>10^6$				142
2-(4'-propylphenyl)-3-ethyl-quinoline	3.1×10^9				235
Pyrene-polymer reactant	3.55×10^7	25	0.952		AlCl ₃ catalyst, mole ratio 1:0:1
Pyromellitontriple, H ₂ S reaction product (polymeric, pyrolyzed)	38.6 to 55 8.0	85	0.72		98 2.87
Pyromellitontriple, NH ₃	1.4 to 1.5×10^{-3}		0.32-0.84	Cooling and heating	287
Pyromellitontriple, methanol reaction product (polymeric, pyrolyzed)	5.4 3.3 2.8×10^{-3}	70 to 227 20 to 70 0.98 0.50	0.30 1.2 0.98 0.50	+	98 287 287
				After heating to 500°C	

Substance	ρ ohm·cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Pyrophyllite (lava)	10 ⁹ to 10 ¹⁴	25			73
Pyrrole, p-benzoquinone Polymer	3.03x10 ⁻⁵	25	0.641		32
Pyrrole, Tetralone polymer	4.95x10 ¹⁰				
Rubeanato - Cu(II)	5x10 ⁴ ac 2.5x10 ⁵ dc	-10 to 80 -10 to 80	0.4 0.3	ZnCl ₂ catalyst, mole ratio 1:1:1 Above 900 decomposes with increasing ρ but E unchanged	32 28
Terephthalate polyesters (unoriented)	10 ⁸ to 10 ¹³				142
Tetracene, anthraquinone polymer	5.11x10 ⁷	25	0.798		
Tetracyanoethylene:					
Metal polymeric chelates					
Reaction time: A 20 hrs B 20 hrs	(A) 0.045 (B) 8600	-80 to 160 -80 to 160	0.06 0.48	+	103
Tetracyanoethylene polymer	10 ⁸	-100 to 300	1.68	-	103
Tetramethylammonium - polyiodide	10 ⁸	20 to 100	1.5	+	142,
2-0-tolybenzimidazole	2.5x10 ⁵	25	1.52		161
2-p-tolybenzimidazole	1x10 ⁶	25	1.42		71
2-m-tolybenzimidazole	1x10 ⁷	25	1.76		71
2,4,5-triiodoimidazole polymers	1.3x10 ⁶				71
1,3,5-trinitrobenzene/I ₂ polymer	1.2x10 ¹³				105
				1.03	142

Substance	ρ ohm·cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Triphenylammonium - polyiodide	10^7 to 10^{10}	20 to 100	1.4 to 2.0		161, 142
Triphthaloylbenzene	3.3×10^{14}	25	1.06		71
Triphenodioxazine	1.3×10^{17}	25	1.68		71
1,3,5-Tris-(2-benzimidazolyl)- benzene	1.6×10^{17}	25	1.58		71
Tris(x-ethylphenyl)- cyanelurine	8×10^6				235
2,4,6-Tris(x-ethylphenyl)-8- triazine	2.4×10^{13}				235
2-Undecyl-quinoline	2.0×10^9	20 to 100	1.4 to 2.0	+	
Xanthene polymer	$7 \times 72 \times 10^3$	20 to 250	0.46	+	112
Zn-imidazole polymer	1015	140			286

TABLE 7

ORGANIC DYES

Substance	ρ ohm. cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Acid Blue 83(CI No. 42660)	3×10^{10}	20	1.67		213, 279
Capri Blue	10^{15}	49	1.67		214
Crystal Violet	10^{10}	-30 to 70	0.74 1.48	- + & -	145 261, 255
Crystal Violet - Cl	10^{10}	~84		~1.2 to 1.4 -	213, 214, 144
Crystal Violet - Sulfate	10^8		-		215, 144
Crystalline Violet	~ 10^{10}	70	1.78		204
Cyananthrone +	1.2×10^7 10^6	33 to 127	0.2 0.2		191, 220
Flavanthrone +	1.4×10^{11}	33 to 127	0.70		142
Fluorescein · Na -	10^{13}	-50 to 150	2.03		213
Gelatin Dye Complexes:					
Basic Fuchsia	10^{20}	90 to 123	2.0 ± 0.2		77, 211, 213 211
			2.9 ± 0.1		
Chlorophyll	10^{22}	100 to 123	2.8 ± 0.4 3.4 ± .2		211
Crystal Violet	4×10^{20}	100 to 115 115 to 140	2.4 ± 0.4 3.0 ± 0.2		211

Substance	ρ ohm. cm	Temp $^{\circ}\text{C}$	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Gelatin Dye Complexes, continued:					
Methylene Blue	4×10^{-14}	40 to 95	1.3 2.10		211 261
Rhodamine B	2×10^{-18}	40 to 95	2.3 ± 0.1	+ & - (Ref. 255)	211
Riboflavin	10 ²⁰	105 to 119	2.1 ± 0.1		211
		119 to 140	2.9 ± 0.1		211
	$> 5 \times 10^{-12}$				212
Indanthrene +	1.4×10^{-15}	33 to 127	0.66		142
Indanthrone +	7.5×10^{-14}	33 to 127	0.63		142
Indanthrone Black +	2.5×10^{-8}	33 to 127	0.56		144
				Ref. 191: $\rho_0 = 3.5 \times 10^3$	191, 77
Indigo	10 ¹³	-50 to 150 40 to 110	1.75 1.75		77 213
Malachite Green	10 ¹¹		1.54		215, 77
Malachite Green - Chloride	10 ¹¹		-		142
Malachite Green solid Solutions	$\sim 10^{-17}$		0.05	+ & -	255 216
Nacrosol Black +	10 ⁷ 10 ¹¹	30 to 140 30 to 140	0.8 1.6		194 194
Orthochrome T	10 ¹³		2.05		219
Orthochrome T +	$> 10^{-15}$	40 to 100	2.05 ± 0.1	+	219
Pinacyanol +	10 ¹⁵	40 to 100	1.8 ± 0.1	-	219, 220
5,6-(N)-Pyridino- 1,9-benzathrone +	8.5×10^{-22}	33 to 170	3.20		142

Substance	ρ ohm. cm	Temp $^{\circ}$ C	E_{in} $E/2kT$	Carrier	Sign of Major- ity	Ref.
Rhodamine B +		60 to 10 10 to -54	1.6 0.32	-	Mobility: 3×10^{-2} cm 2 /V. sec	142
Rhodamine B	10^{12}	< 60	1.2	-	Mobility: 1 cm 2 /V. sec	215, 142 255

TABLE 8

BIOLOGICAL MATERIALS

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Adenine	1.7×10^{16}	120	2.4		
Adenine phosphate	$\sim 10^{15}$		2.0		
Adenosine	$\sim 10^{15}$		4.5		221
Adenosine triphosphate (ATP)	$\sim 10^{15}$		2.0		221
Adenylic acid, yeast	$\sim 10^{15}$		1.8		221
Adenylic acid, muscle	$\sim 10^{15}$		2.0		221
Acetioporphyrin -1	3.31×10^{13}	100 to 370	1.99 @ 127°		218
Acetioporphyrin -1, Co	1.66×10^{11}	180 to 40	1.87 @ 127°		218
Acetioporphyrin -1, Cu	3.47×10^{11}	160 to 45	1.82 @ 127°		218
Acetioporphyrin-1, Mg	1.45×10^{13}		1.86 @ 127°		218
Acetioporphyrin-1, Ni	7.76×10^{11}	> 170 to 45	1.81 @ 127°		218
α-Alanine	5.3×10^{14} 5.3×10^{14}	127 127	3.31 2.16		222
β-Alanine	5.3×10^{12}	127	4.07		222
Albumen, serum	$> 10^{10}$				142
Albumen	10^{16} to 10^{17}	40 to 100	2.26		
Bovine Plasma albumen	7.9×10^{11}	127	2.78		224
Collagen	2.9×10^{13}	117	2.73		224

Ref. 289: specific conductance = 3,
E = 2.6 e.v. m.p. 360-50°C
 2×10^6 dynes/cm²

Substance	ρ ohm-cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Coproporphyrin - III	5.0×10^{11}	127	1.91		218
Cytidilic acid	$\sim 10^{15}$		2.2	m. p. 231-3°C d.	142
Cytidine	10 ¹¹ to 10 ¹³		4.9	m. p. 230-1°C d.	221
Cytochrome C	3.8×10^{11}	127	2.60		224
Cytosine	3.5×10^{14}	120	2.4	Ref. 289: specific conductance = 0.25, $E=2.4$ e. V., m. p. 154°C	217
DNA	(dried)				288
	5×10^{11}	170 to 60	2.42±0.5		288
	2×10^4 ac	127	2.42		218
(calf thymus)	10^{16}	20 to 95	1.7	Ref. 289: specific conductance = 10^7 , $E=2.1$	142
Na salt, native	10^{11}	20 to 50	1.52		225
Na salt, denatured	10^{13}	20 to 50	1.52		225
Na salt, heat treated	10^{12}	20 to 50	1.70		225
Mg salt	10^{15}	20 to 50	1 to 1.4		225
Diketopiperazine	1.3×10^{10}	> 157	2.19		222
Dioxyribonucleic acid	10^{13}	90	2.44 and 1.90 ± 0.4 ev	$\rho_o = 1.6 \times 10^{-3}$	275, 280
Elastin	2.0×10^{14}	127			224
Fibrinogen	6.2×10^{11}	127	2.69	$\rho_o = 10^8$ ohm cm	224
Gelatin (fully hydrated)	10^9 2×10^{22}	110 to 140	2.96	Ref. 228: $E=2.2$; Ref. 250: heat of solution 23. 24 ± 0.25 cal/g	142
				Ref. 251: energy of activation for removal of H_2O , 1.6 kcal/mole (100-200°C) HAc treated, 0.46 kcal/mole untreated	

Substance	ρ ohm. cm	Temp $^{\circ}$ C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.	
Gelatin (fully hydrated), continued: (completely dry)	1.25×10^{18} 4.7×10^{13}	117	3.05		142 224	
Globin	4.5×10^{13}	100 to 160	2.97@127 $^{\circ}$ C		222	
Glycine (single crystal) \perp ac	6.4×10^{13}	127 to 155	3.2		222	
(single crystal) \perp ac	6.4×10^{13}	90 to 127	2.67		222	
(single crystal) \parallel ac	1.8×10^{13}	127 to 155	2.82		222	
(single crystal) \parallel ac (compressed powder)	1.8×10^{13} 1.7×10^{12}	90 to 127	1.99 2.92		222	
Glycine - Cu chelate	10^{15}	127			222	
Guanine	1.2×10^{16}	120	2.6			
				Ref. 289: specific conductance = 0.003, m.p. 360 $^{\circ}$ C; d., $E = 1.96$ e.V.	217	
Guanylic acid	$\sim 10^{15}$		1.5		221	
Guanosine	10^{11} to 10^{12}		2.1		221	
Hematin	1.3×10^{12}	20 to 180	1.74@127 $^{\circ}$ C		222	
Hemoglobin (denatured)	10^8	2.89			226, 224	
				Ref. 228 for bovine hemoglobin	222	
Heme, ferric	4.6×10^{12}	84 to 140	2.75@127 $^{\circ}$ C +		173	
Hemoglobin (natural)	1.32×10^{12} 5.4×10^{11}	127	1.80		Ref. 258: dipole moment = 380D Dielectric relaxation time $T_0 = 1.45 \times 10^{-8}$ sec	224
		117	2.66			
(denatured)	1.1×10^{12}	117	2.89		224	
Insulin, pig	3.2×10^{12} 7.3×10^{14}	117 120 to 200	2.91 3.13		224 224	

Substance	ρ ohm. cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Keratin	10 ⁸				142
Lysozyme	3.9x10 ¹¹	127	2.62		224
Melanin from Japanese squid	3x10 ¹⁰				84
Oxamide	2.7x10 ¹⁵				222
Plasma albumen (dry) (moist)	8x10 ¹⁷ 3x10 ¹²		2.80 1.06		144 81
Plasma, bovine (chloranil complex)	1.6x10 ¹³ 2.0x10 ¹³	117 127	2.99 3.12		227 227
Polyglycine					224
Poly-L-tyrosine, helical random coil	1.6x10 ¹² 4.7x10 ¹²	117 117	2.99 2.98		224 224
Protein, dry	10 ¹⁸			+and-	142
RNA, yeast	3.02x10 ¹¹	170 to 60	2.42±0.05		218
Riboflavin	10 ¹⁴		2.4		221
Thrombin	2.6x10 ¹¹	127	2.59		224
Thymidine	10 ¹¹ to 10 ¹³		4.7		Ref. 289: Specific conductance = 0.25, $E=2.4$ e. V.
Thymine	9x10 ¹⁴	120	1.96		m. p. 226°C m. p. 185°C
Thymus nucleoprotein	6.2x10 ¹¹	127	2.57		217 289
Tobacco mosaic virus	1.1x10 ¹³	127	2.92		224 224

Substance	ρ ohm.cm	Temp °C	E in $E/2kT$	Sign of Major- ity	Ref.
Tyrosine (DL)	1.1×10^{-15}	127	2.2	m.p. 316-200°C d.	222
Uracil	8.5×10^{-15}	120	2.72	Ref. 289: Specific conductance = 30; 217 $E = 2.72$ e.V.; m.p. 338°C	
Uridine	10^{-11} to 10^{-13}	5.2		m.p. 164-5°C	221

TABLE 9

LIQUIDS AND GLASSES

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Benzene	10 ⁴	17 to 60	1.16 to 0.84±0.08	saturated with air	77
	1.45x10 ¹⁴			Ref. 253: electron affinity (PhCl=1) =0.01	77 142
	1.64x10 ¹⁵			m. p. 5.5°C saturated with air in N ₂	142
	$\Delta H_{298} = +11,630$ cal., $\Delta S_{298} = -59.6$ e.w., $\Delta G_{298} = 29,400$			+2, large space charges	244
Chlorpromazine	10 ⁻²	32	2.1	m. p. 59-60°C	186
1, 3-Cyclohexadiene	1.5x10 ¹⁴	20 to 65	1.5x10 ¹⁴		233
1, 4-Cyclohexadiene	2x10 ¹⁶	20 to 65	0.84		233
Cyclohexane	>10 ¹⁶	20 to 65	0.32	m. p. 6.5°C	233
	1.2x10 ¹⁵	5 to 72	1.9	saturated with water at the freezing point	233
	$\rightarrow \infty$	0			233
Cyclohexene	6.7x10 ¹⁴	20 to 65	0.84	m. p. -103.50°C	233
Dimethylbenzene	1.5x10 ¹⁵		0.82		233
n-Heptane	>10 ¹⁰	20 to 65	0.30		233, 142
n-Hexane	10 ¹⁶ to 10 ¹⁷		0.32	Mobility: $1.4 \pm 0.1 \times 10^{-3}$ cm ² /V·sec	233, 142
Methylcyclohexane	>10 ¹⁶	20 to 65	0.32		233
Salanil	2.8x10 ⁸		0.8		92
Toluene	1.25x10 ¹⁴		0.82	m. p. -95°C	233
1, 2, 4-Trimethylbenzene	1.15x10 ¹⁵		0.84		233
1, 3, 5-Trimethylbenzene	10 ¹⁶		0.38		233
m-xylene				$\rho_0 = 1 \times 10^8$ ohm cm $\Delta S_{298} = 0106.3$ e.w., $\Delta G_{298} = +27,000$ cal	77 244
				$\Delta H_{298} = -4,670$ cal., $\Delta S_{298} = 0106.3$ e.w., $\rho_0 = 1 \times 10^8$ ohm cm	

Substance	ρ ohm·cm	Temp °C	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
O-xylene		0.90		$\rho_o = 3 \times 10^9$ ohm cm	77
				$\Delta H_{298} = -4,670$ cal., $\Delta S_{298} = -107.3$ e.w., $\Delta G_{298} = +27,300$ cal	244
P-Xylene		0.82		$\rho_o = 1 \times 10^8$ ohm cm	77
				$\Delta H_{298} = -8,470$ cal., $\Delta S_{298} = -106.1$ e.w., $\Delta G_{298} = +23,200$ cal	
Zn-9-anthrone	10^{14} to 10^{17}			+	142

In the following, conductivity was found to depend on temperature exponentially. Samples were examined as solids and as liquids.

Acridine	10^{13} to 10^{22}	25			300
Anthracene	10^{13} to 10^{22}	25			300
Benzanthrone	10^{13} to 10^{22}	25			300
β -Methylnaphthalene	10^{13} to 10^{22}	25			300
Naphthalene	10^{13} to 10^{22}	25			300
α -Naphthol	10^{13} to 10^{22}	25			300
β -Naphthol	10^{13} to 10^{22}	25			300
α -Naphthoquinoline	10^{13} to 10^{22}	25			300
β -Naphthoquinoline	10^{13} to 10^{22}	25			300
Phenanthrene	10^{13} to 10^{22}	25			300
α -Phenanthroline	10^{13} to 10^{22}	25			300
Phenazine	10^{13} to 10^{22}	25			300
1-Phenylazo-2-naphthol	10^{13} to 10^{22}	25			300
1-(o-Tolylazo)-2-naphthol	10^{13} to 10^{22}	25			300

TABLE 10
PHYSICAL PROPERTIES OF COMMERCIALLY AVAILABLE PLASTICS

FROM REFERENCE 242:

PHYSICAL PROPERTIES OF COMMERCIALLY AVAILABLE PLASTICS
ABS (ACRYLONITRILE - BUTADIENE - STYRENE)

<u>Properties</u>	<u>Extrusion Grade</u>	<u>High Impact</u>	<u>High Heat Resistance</u>	<u>Medium Impact</u>
Specific gravity	0.99 to 1.15	1.02 to 1.2	1.03 to 1.2	1.02 to 1.2
Specific volume, cu.in/lb.	24 to 28	-	23 to 27	-
Refractive index, n_D	-	-	-	-
Tensile strength, psi	2400 to 6500	4500 to 7000	6000 to 7500	5500 to 7000
Elongation, %	-	-	-	-
Tensile modulus, 10^5 psi	1 to 3.3	2 to 3.5	3 to 4	2.8 to 4
Compressive strength, psi $\times 10^3$	2.5 to 6.5	4.5 to 7.0	6.0 to 7.5	5.5 to 7.0
Flexural strength, psi $\times 10^3$	4.0 to 10.0	7.0 to 10.5	9.0 to 12.0	8.0 to 11.0
Impact strength, ft.-lb/in.	1.8 to 10	3 to 7	1 to 4.5	0.7 to 2.5
Hardness, Rockwell	30 to 105	80 to 110	100 to 120	95 to 115
Thermal conductivity, 10^{-4} cal. / sec. /sq.cm., / $1^{\circ}\text{C.}/\text{cm}$)	4.6 to 8	4.6 to 8	4.6 to 8	4.6 to 8
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	0.3 to 0.4	0.3 to 0.4	0.3 to 0.4	0.3 to 0.4
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	9 to 13	9 to 11	5.5 to 8.5	7.5 to 9
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	140 to 200	170 to 210	190 to 230	160 to 200
Deflection temp., $^{\circ}\text{F}$	140 to 200	175 to 210	195 to 230	175 to 200
@ 264 psi fiber stress	190 to 215	190 to 215	215 to 245	190 to 210
@ 66 psi fiber stress				

Volume resistivity, ohm-cm.	0.5x10 ¹³ - 4x10 ¹⁶	1-4x10 ¹⁶	1.5x10 ¹⁶	1.5-4x10 ¹⁶
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	400 to 550 350 to 500	400 to 550 350 to 500	400 to 550 350 to 500	400 to 550 350 to 500
Dielectric constant, 60 cycles	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4
10 ³ cycles	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4
10 ⁶ cycles	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4
Dissipation (power) factor 60 cycles	0.003-0.013	0.003-0.013	0.003-0.013	0.003-0.013
10 ³ cycles	0.003-0.013	0.003-0.013	0.003-0.013	0.003-0.013
10 ⁶ cycles	0.005-0.015	0.005-0.015	0.005-0.015	0.005-0.015
Arc resistance, sec.	55 to 90	55 to 90	55 to 90	55 to 90
Water absorption, 24 hr., %	0.25 to 0.45	0.25 to 0.45	0.25 to 0.45	0.25 to 0.45
Burning rate (flammability, in./min.)	slow	slow	slow	slow
Effect of sunlight	none	none	none	none
Effect of weak acids	none	none	none	none
Effect of strong acids	attacked by oxidizing acids	none	none	none
Effect of weak alkalis	none	none	none	none
Effect of strong alkalis	none	none	none	none
Effect of organic solvents	soluble in ketones, esters, and some chlorinated hydrocarbons	good to excellent		
Machining qualities				

PROPERTIES	Acetal ¹			Acrylic Methyl Methacrylate		
	Homopolymer	Copolymer	Cast	Molding	Cast	Molding
Specific gravity (density)	1.425	1.41	1.17-1.20	1.17-1.20	1.17-1.20	1.17-1.20
Specific volume, cu.in./lb.	19.5	19.7	23.1 to 23.7	23.1 to 23.7	23.1 to 23.7	23.1 to 23.7
Refractive index, n _D	1.48	-	1.48 to 1.50	1.48 to 1.50	1.49	1.49
Tensile strength, psi	10000	8800 (73°F.)	8000 to 11000	8000 to 11000	7000 to 11000	7000 to 11000
Elongation, %	15(inj); 75(Ext)	60 to 75	2 to 7	2 to 7	2 to 10	2 to 10
Tensile modulus, 10 ⁵ psi	4.10	4	3.5 to 5.0	3.5 to 5.0	4.5	4.5
Compressive strength, psi x 10 ⁻³	18. (10% defl)	16. (10% defl)	11. to 19.	11. to 19.	12. to 18.	12. to 18.
Flexural strength, psi x 10 ⁻³	14	13	12 to 17	12 to 17	13 to 17	13 to 17
Impact strength, ft.-lb/in.	1.4(inj); 2.3(ext)	1.2 to 1.4	0.4 to 0.5	0.4 to 0.5	0.3 to 0.5	0.3 to 0.5
Hardness, Rockwell	M94, R120	M78 to M80	M80 to M100	M80 to M100	M85 to M105	M85 to M105
Thermal conductivity 10 ⁻⁴ cal./ sec./sq. cm., 1(°C./cm)	5.5	5.5	4 to 6	4 to 6	4 to 6	4 to 6
Specific heat, cal./°C per gm.	0.35	0.35	0.35	0.35	0.35	0.35
Thermal expansion, 10 ⁻³ per °C	8.1x10 ⁻⁵	8.1x10 ⁻⁸	5 to 9	5 to 9	5 to 9	5 to 9
Resistance to heat, °F (continuous)	195	220	140 to 200	140 to 200	140 to 190	140 to 190
Deflection temp., °F @ 264 psi fiber stress	255	230	160 to 215	160 to 215	155 to 210	155 to 210
@ 66 psi fiber stress	338	316	165 to 235	165 to 235	165 to 225	165 to 225

Volume resistivity, ohm-cm.	6×10^{14}	1×10^{14}	$> 10^{15}$	$> 10^{14}$
Dielectric strength (short time) volts/mil	465-1900	500 (90 mil)	450-550	450-550
(step-by-step) volts/mil	400	-	350-400	350-400
Dielectric constant, 60 cycles	-	3.8	3.5 to 4.5	3.5 to 4.5
10^3 cycles	3.7	3.8	3.0 to 3.5	3.0 to 3.5
10^6 cycles	3.7	3.8	2.2 to 3.2	2.2 to 3.2
Dissipation (power) factor 60 cycles	-	-	0.05-0.06	0.04-0.06
10^3 cycles	0.004	0.004	0.04-0.06	0.03-0.05
10^6 cycles	0.004	0.005-0.007	0.02-0.03	0.02-0.03
Arc resistance, sec.			no track	no track
Water absorption, 24 hr., %	0.25	0.22	0.3 to 0.4	0.3 to 0.4
Burning rate (flammability, in./min.)	slow (1.1)	slow (1.1)	slow (1.0-1.3)	slow (0.9-1.2)
Effect of sunlight	chalks slightly	chalks slightly	nil	nil
Effect of weak acids	resists some	resists some	nil	nil
Effect of strong acids	attacked	attacked	attacked only by high conc. oxidizing acids	attacked only by high conc. oxidizing acids
Effect of weak alkalies	resists some	none	nil	nil
Effect of strong alkalies	resists some	none	attacked	attacked
Effect of organic solvents	excellent resistance		soluble in ketones, esters, aromatic & chlorinated solvents	
Machining qualities	excellent	excellent	fair to excellent	good to excellent

	Acrylic	Allyl Monomer	Impact Acrylic	Methyl Methacrylate/ styrene copolymer	α -methylstyrene copolymer	Molding Compound	Cast Allyl
PROPERTIES							
Specific gravity (density)				1.08-1.16	1.16	1.08-1.18	1.30-1.40
Specific volume, cu. in./lb.				23.8-25.6	24	23.3-25.6	19.8-20.9
Refractive index, n_D				1.533-1.565	1.519	not appl.	1.50-1.575
Tensile strength, psi	9000 to 11000	9000	5000 to 9000	2 to 5	3	> 15 to 50	5000 to 6000
Elongation, %	4.4 to 5.0	4.8	2.0 to 4.0	11 to 15	18	4 to 14	3.0
Tensile modulus, 10^5 psi				16 to 19	15	8 to 13	21 to 23
Compressive strength, psi $\times 10^{-3}$				0.35 to 0.50	0.3	0.5 to 4.5	6 to 13
Flexural strength, psi $\times 10^{-3}$				M70 to M85	M104-M107	R99 to R120	M95 to R120
Impact strength, ft. -lb./in.				3.0 to 4.0	-	4 to 5	4.8 to 5
Hardness, Rockwell							
Thermal conductivity 10^{-4} cal./ sec. /sq. cm., $/10^6$ C./cm.)	0.34	0.35	0.34				0.26-0.55
Specific heat, cal./ $^{\circ}$ C per gm.	6 to 8	5.4×10^{-3}	6 to 8				5 to 10
Thermal expansion, 10^{-3} per $^{\circ}$ C	180 to 200	260	160 to 185				212
Resistance to heat, $^{\circ}$ F (continuous)							
Deflection temp., $^{\circ}$ F	185 to 210	244 to 252	165 to 215				140 to 190
@ 264 psi fiber stress	-	260 to 267	180 to 225				-
@ 66 psi fiber stress							

Volume resistivity, ohm-cm.	> 10 ¹⁶	-	-	2.0x10 ¹⁶	> 4x10 ¹⁴
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	400 to 500	475	400 to 500	380	320
Dielectric constant, 60 cycles	-	-	3.0 to 4.0	3.45 to 5.0	
10 ³ cycles	3.13	3.12	2.5 to 3.5	3.35 to 5.0	
10 ⁶ cycles	2.81	3.03	2.0 to 3.0	3.6 to 4.5	
Dissipation (power) factor 60 cycles	-	0.039	0.03 to 0.04	0.006-0.019	
10 ³ cycles	0.025	0.028	0.02 to 0.035	0.01	
10 ⁶ cycles	0.019	0.011	0.01 to 0.02	0.028-0.06	
Arc resistance, sec.	-	-	no track	120 to 250	
Water absorption, 24 hr., %	0.2	0.2	0.2 to 0.4	0.03 to 0.44	
Burning rate (flammability, in. /min.)	slow	slow(1.7)	slow	0.3 to self-extinguishing (1.0 to 0.3)	
Effect of sunlight	nil	nil	sl. strength loss	yellow v. slightly	
Effect of weak acids	none	nil	pract. nil	none	
Effect of strong acids	- attacked by high conc. of oxidizing acids			only by oxidizing acids	
Effect of weak alkalies	none	nil	pract. nil	none	
Effect of strong alkalies	none	nil	pract. nil	none to slight	
Effect of organic solvents				soluble in ketones, esters, aromatic and chlorinated hydrocarbons	resistant
Machining qualities	good to excellent	good			

Cellulosic Molding Compound and Sheets
Cellolose Acetate

Ethy1 Cellulose Molding Cpd. and Sheets	Sheet	Molding	High Acetyl
PROPERTIES			
Specific Gravity (density)	1.09 to 1.17	1.28 to 1.32	1.23 to 1.34
Specific volume, cu. in./lb.	23.6 to 25.5	20.9 to 21.6	20.6 to 22.5
Refractive index, n_D	1.47	1.49 to 1.50	1.46 to 1.50
Tensile strength, psi	2000-8000	4500-8000	1900-8500
Elongation, %	5 to 40	20 to 50	6 to 70
Tensile modulus, 10^5 psi	1.0 to 3.0	3.4	0.65 to 4.0
Compressive strength, psi $\times 10^{-3}$	10 to 35	18 to 25	2.2 to 36
Flexural strength, psi $\times 10^{-3}$	4 to 12	6 to 10	0.2 to 16
Impact strength, ft. -lb/in.	2.0 to 8.5	1.0 to 3.0	0.4 to 5.2
	0.3 to 1.7	0.3 to 1.7	0.4 to 5.2
	-40°F		
Hardness, Rockwell	R50 to R115	R95 to R120	R35 to R125
Thermal conductivity 10^{-4} cal./ sec. /sq. cm., /$1^{\circ}\text{C.}/\text{cm.}$	3.8 to 7	4 to 8	4 to 8
Specific heat, cal./$^{\circ}\text{C}$ per gm.	0.3 to 0.75	0.3 to 0.5	0.3 to 0.42
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	10 to 20	10 to 15	8 to 16
Resistance to heat, °F (continuous)	115 to 185	140 to 220	140 to 220
Deflection temp, °F	115 to 190	130 to 160	111 to 190
@ 264 psi fiber stress	-	-	118 to 195
@ 66 psi fiber stress	-	-	120 to 205
			130 to 212

Volume resistivity, ohm-cm.	10 ¹² to 10 ¹⁴	10 ¹¹ to 10 ¹³	10 ¹⁰ to 10 ¹²	10 ¹⁰ to 10 ¹⁴	10 ¹⁰ to 10 ¹³
Dielectric strength (short time) volts/mil	350 to 500	250 to 300	250 to 365	250 to 365	250 to 365
(step-by-step) volts/mil	300 to 500	-	200 to 300	200 to 300	200 to 300
Dielectric constant, 60 cycles	3.0 to 4.2	4.7	3.5 to 7.5	4.7	4.7
10 ³ cycles	3.0 to 4.1	4.5	3.5 to 7.0	4.5	4.5
10 ⁶ cycles	2.8 to 3.9	4.4	3.2 to 7.0	4.4	4.4
Dissipation (power) factor 60 cycles	0.005-0.020	0.018	0.01-0.06	0.018	0.018
10 ³ cycles	0.002-0.020	0.022	0.01-0.06	0.022	0.022
10 ⁶ cycles	0.010-0.060	0.051	0.01-0.10	0.051	0.051
Arc resistance, sec.	60 to 80	180 to 200	50 to 310	50 to 310	50 to 310
Water absorption, 24 hr., %	0.8 to 1.8	2.0 to 4.5	1.9 to 6.5	1.3 to 2.0	—
Burning rate (flammability, in./min.)	slow	—	slow to self-extinguishing	—	—
Effect of sunlight	slight	no visible change	slight	slight	slight
Effect of weak acids	slight	no visible change	slight	slight	slight
Effect of strong acids	decomposes	decomposes	decomposes	decomposes	decomposes
Effect of weak alkalies	none	no visible change	slight	no visible change	no visible change
Effect of strong alkalies	slight	swells	decomposes	decomposes	decomposes
Effect of organic solvents	widely soluble	soluble in liquid ketones and esters, softened or dissolved by chlorinated & aromatic hydrocarbons	—	—	—
Machining qualities	good	good	excellent	good	good

Cellulosic Molding Compound and Sheets

Cellulose	Propionate	Cellulose	Cellulose
Molding Compound	Molding	Sheet	Acetate-Butyrate
Properties			Nitrate (Pyroxylin)
Specific gravity (density)			
Specific volume, cu. in/lb.	1.18 to 1.24	1.15 to 1.22	1.15 to 1.22
Refractive index, n_D	22.5 to 23.4	22.7 to 24.0	22.7 to 24.0
Tensile strength, psi	1.46 to 1.49	1.46 to 1.49	1.46 to 1.49
Elongation, %	2000 to 7800	2600 to 6900	2600 to 6900
Tensile modulus, 10^5 psi	29 to 100	60 to 100	60 to 88
Compressive strength, psi $\times 10^{-3}$	0.6 to 2.15	2.0 to 2.5	0.5 to 2.0
Flexural strength, psi $\times 10^{-3}$	3.1 to 22.0	-	2.1 to 22.0
Impact strength, ft.-lb/in.	3.2 to 11.4	4.0 to 9.0	1.8 to 9.3
Hardness, Rockwell	0.5 to 11.5	0.8 to 6.3	0.8 to 6.3
Thermal conductivity 10^{-4} cal. / sec. /sq. cm., / $^{\circ}$ C. /cm.)	R10 to R122	R30 to R115	R31 to R116
Specific heat, cal. / $^{\circ}$ C per gm.	4 to 8	4 to 8	4 to 8
Thermal expansion, 10^{-3} per $^{\circ}$ C	0.3 to 0.40	0.3 to 0.4	0.3 to 0.4
Resistance to heat, $^{\circ}$ F (continuous)	11 to 17	11 to 17	11 to 17
Deflection temp., $^{\circ}$ F	155 to 220	140 to 220	140 to 220
@ 264 psi fiber stress	111 to 228	113 to 202	113 to 202
@ 66 psi fiber stress	158 to 250	130 to 227	130 to 227

Volume resistivity, ohm-cm.	10^{12} to 10^{16}	10^{11} to 10^{15}	10^{11} to 10^{15}	$(10-15) \times 10^{10}$
Dielectric strength (short time) volts/mil	300 to 450	250 to 400	250 to 400	300 to 600
(step-by-step) volts/mil	300 to 375	-	-	250 to 550
Dielectric constant, 60 cycles	3.7 to 4.0	4.7	3.5 to 6.4	7.0 to 7.5
10^3 cycles	3.6 to 4.0	4.5	-	7.0
10^6 cycles	3.4 to 3.6	4.4	3.2 to 6.2	6.4
Dissipation (power) factor 60 cycles	0.01 to 0.04	0.018	0.01 to 0.04	0.09 to 0.12
10^3 cycles	0.0 to 0.04	0.022	-	0.03
10^6 cycles	0.01 to 0.04	0.051	0.01 to 0.04	0.06 to 0.09
Arc resistance, sec.	175 to 190	-	-	-
Water absorption, 24 hr., %	1.2 to 2.8	0.9 to 2.2	0.9 to 2.2	1.0 to 2.0
Burning rate (flammability, in. /min.)	slow (1.0 to 1.3) slow	slow	very fast	
Effect of sunlight	slight	no visible change	slight	discolors and becomes brittle
Effect of weak acids	slight	no visible change	slight	slight
Effect of strong acids	decomposes	decomposes	decomposes	decomposes
Effect of weak alkalies	slight	no visible change	slight	slight
Effect of strong alkalies	decomposes	decomposes	decomposes	decomposes
Effect of organic solvents		soluble in ketones and esters, softened or dissolved by chlorinated and aromatic hydrocarbons	widely soluble	
Machining qualities	excellent	good	excellent	excellent

PROPERTIES	Chlorinated Polyether		Epoxy Resins	
	No filler	Cast Resins Silica Filler	No filler	Flexibilized
Specific gravity (density)	1.4	1.11 to 1.40	1.6 to 2.0	1.05 to 1.35
Specific volume, cu. in/lb.	19.8	20 to 24.9	17.3 to 13.9	20.5
Refractive index, n_D	-	1.55 to 1.61	-	-
Tensile strength, psi	6000	4000-13000	7000-13000	2000-10000
Elongation, %	60 to 160	3 to 6	1 to 3	20 to 70
Tensile modulus, 10^5 psi	1.6	3.5	-	0.01 to 3.5
Compressive strength, psi $\times 10^{-3}$	-	15.0 to 25.0	15.0 to 35.0	1.0 to 14.0
Flexural strength, psi $\times 10^{-3}$	5.0	13.3 to 21.0	8.0 to 14.0	1.0 to 13.0
Impact strength, ft.-lb/in.	0.4	0.2 to 1.0	0.3 to 0.45	3.5 to 5
Hardness, Rockwell	R-100	M80 to M110	M85 to M120	-
Thermal conductivity 10^{-4} cal. / sec. / sq. cm., / $1(^{\circ}\text{C.}/\text{cm.})$	3.1	4 to 5	10 to 20	-
Specific Heat, cal. / $^{\circ}\text{C}$ per gm.	-	0.25	0.20 to 0.27	-
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	8.0	4.5 to 6.5	2.0 to 4.0	2 to 10
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	290	250 to 550	250 to 550	250 to 300
Deflection temp., $^{\circ}\text{F}$	@ 264 psi fiber stress	115 to 550	160 to 550	RT to 250
@ 66 psi fiber stress				
	285	-	-	-

Volume resistivity, ohm-cm.	10 ¹⁵	10 ¹² to 10 ¹⁷	10 ¹³ to 10 ¹⁶	1.3-15x10 ¹⁴
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	400	400 to 500	400 to 550	235 to 400
Dielectric constant, 60 cycles	-	380	-	235 to 400
10 ³ cycles	3.1	3.5 to 5.0	3.2 to 4.5	3 to 6
10 ⁶ cycles	3.0	3.5 to 4.5	3.2 to 4.0	3 to 5
2.9	3.3 to 4.0	3.0 to 3.8	3 to 6	
Dissipation (power) factor 60 cycles	0.01	0.002-0.010	0.008-0.03	0.010-0.040
10 ³ cycles	0.01	0.002-0.02	0.008-0.03	0.012-0.050
10 ⁶ cycles	0.01	0.030-0.050	0.02-0.04	0.018-0.090
Arc resistance, sec.	-	45 to 120	150 to 300	50 to 180
Water absorption, 24 hr., %	0.01	0.08-0.15	0.04-0.10	0.27-0.5
Burning rate (flammability, in./min.)	self-extinguishing	slow	self-extinguishing	slow
Effect of sunlight	slight	none	none	none
Effect of weak acids	none	none	none	none
Effect of strong acids	attacked by oxidizing acids	some	attacked by some	attacked by some
Effect of weak alkalies	none	none	none	none
Effect of strong alkalies	resists most	slight	slight	slight
Effect of organic solvents	excellent	good	generally resistant	good
Machining qualities	poor	poor	good	good

	Epoxy Resins		
	Molding Compounds	Encapsulating Grades	
	Glass Filled	Mineral Filled	Mineral Filled Glass Filled
PROPERTIES			
Specific gravity (density)	1.6 to 2.0	1.6 to 2.0	1.7 to 2.1
Specific volume, cu.in./lb.	14 to 15.4	13.4 to 14.2	14
Refractive index, n_D	-	-	-
Tensile strength, psi	10000-30000	5000-15000	4000-10000
Elongation, %	4	-	-
Tensile modulus, 10^5 psi	30.4	-	-
Compressive strength, psi	$\times 10^{-3}$	25.0 to 40.0	18.0 to 40.0
Flexural strength, psi	$\times 10^{-3}$	10.0 to 60.0	8.0 to 15.0
Impact strength, ft.-lb/in.	10.0	0.3 to 0.4	0.3 to 0.45
Hardness, Rockwell	M100 to M110	M100 to M110	M100 to M112 M100 to M112
Thermal conductivity 10^{-4} cal. / sec. / sq. cm., / $1(^{\circ}\text{C.}/\text{cm.})$	4 to 10	4 to 30	4 to 10
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	0.19	-	-
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	1.1 to 3.5	2.0 to 5.0	3 to 6
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	300 to 500	300 to 500	300 to 450
Deflection temp., $^{\circ}\text{F}$	250 to 500	250 to 500	225 to 450
@ 264 psi fiber stress	-	-	-
@ 66 psi fiber stress	-	-	-

Volume resistivity, ohm-cm.	> 10 ¹⁴	> 10 ¹⁴	> 10 ¹⁴	> 10 ¹⁴	> 10 ¹⁴
Dielectric strength (short time) volts/mil	300 to 400	300 to 400	300 to 400	250 to 400	250 to 400
(step-by-step) volts/mil	300 to 400	300 to 400	300 to 400	250 to 400	250 to 400
Dielectric constant, 60 cycles	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0
10 ³ cycles	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0
10 ⁶ cycles	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0
Dissipation (power) factor 60 cycles	0.01	0.01	0.01	0.01	0.01
10 ³ cycles	0.01	0.01	0.01	0.01	0.01
10 ⁶ cycles	0.01	0.01	0.01	0.01	0.01
Arc resistance, sec.	120 to 180	150 to 190	120 to 180+	120 to 180+	120 to 180+
Water absorption, 24 hr., %	0.05 to 0.2	0.04	0.03 to 0.2	0.04 to 0.2	—
Burning rate (flammability, in./min.)	— self-extinguishing —	— self-extinguishing —	— self-extinguishing —	— self-extinguishing —	to non-burning
Effect of sunlight	slight	slight	slight	slight	slight
Effect of weak acids	none	none	none	none	none
Effect of strong acids	negligible	none	slight	slight	slight
Effect of weak alkalies	none	none	slight	slight	slight
Effect of strong alkalies	none	slight	— slight to attack —	— slight to attack —	— slight to attack —
Effect of organic solvents	none	none	slight	slight	slight
Machining qualities	fair to good	fair	fair to good	fair	fair

PROPERTIES		Fluoroplastics			Fluoropolymers		
Specific gravity (density)	Polychloro- Trifluoro- Ethylene	Polytetrafluoro- ethylene Molding Compound	FEP	Poly- vinylidene Fluoride	Poly- vinylidene Fluoride		
Specific volume, cu. in/lb.	2.1 to 2.2	2.13 to 2.22	2.12 to 2.17	1.76 to 1.77			
Refractive index, n_D	12.7 to 13.2	12.6 to 13.2	12.8 to 13.0	15.6 to 15.7			
Tensile strength, psi	1.425	1.35	1.338	1.42			
Elongation, %	4500 to 6000	2000 to 4500	2700 to 3100	7000			
Tensile modulus, 10^5 psi	80 to 250	200 to 400	250 to 330	100 to 300			
Compressive strength, psi	$1.5 \text{ to } 3$	0.58	0.5	1.2			
Flexural strength, psi	$x10^{-3}$	$4.6 \text{ to } 7.4$	1.7	-			
Impact strength, ft. -lb/in.	$x10^{-3}$	$7.4 \text{ to } 9.3$	-	-			
Hardness, Rockwell	4.7 to 5.3	2.5 to 2.7	3.0	no break			
Thermal conductivity 10^{-4} cal. / sec. /sq. cm., / $(^{\circ}\text{C.})$ /cm.)	R75 to R95	R50 to D65	R25	D-90(Shore)			
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	0.22	0.25	0.28	0.33			
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	4.5 to 7.0	10	8.3 to 10.5	12			
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	350 to 390	550	400	300			
Deflection temp., $^{\circ}\text{F.}$	-	-	-	-			
@ 264 psi fiber stress	-	-	-	195			
@ 66 psi fiber stress	258	250	-	300			

Volume resistivity, ohm-cm.	1.2x10 ¹⁸	>10 ¹⁸	>2x10 ¹⁸	>2x10 ¹⁸
Dielectric strength (short time) volts/mil	500 to 600	480	500 to 600	260
(step-by-step) volts/mil	450 to 550	430	-	-
Dielectric constant, 60 cycles	2.24 to 2.8	2.1	2.1	8.4
10 ³ cycles	2.3 to 2.7	2.1	2.1	8.0
10 ⁶ cycles	2.3 to 2.5	2.1	2.1	6.6
Dissipation (power) factor 60 cycles	0.0012	<0.0002	<0.0003	0.049
10 ³ cycles	0.023 to 0.027	<0.0002	<0.0003	0.018
10 ⁶ cycles	0.009 to 0.017	<0.0002	<0.0003	0.17
Arc resistance, sec.	>360	>200	>165	50 to 70
Water absorption, 24 hr., %	0.00	0.00	0.01	0.04
Burning rate (flammability, in./min.)	none	none	none	self extinguishing
Effect of sunlight	none	none	none	sl. bleaching on long exposures
Effect of weak acids	none	none	none	none
Effect of strong acids	none	none	none	attacked by fuming sulfuric
Effect of weak alkalies	none	none	none	none
Effect of strong alkalies	none	none	none	none
Effect of organic solvents	none	none	none	resists most
Machining qualities	excellent	excellent	excellent	excellent

Melanine-Formaldehyde Molding Compounds

PROPERTIES	Ionomers	α-Cellulose Filler	Asbestos Filler	Macer. ted Fabric Filler
Specific gravity (density)	0.93 to 0.95	1.47 to 1.52	1.70 to 2.0	1.5
Specific volume, cu. in./lb.	29.2 to 29.8	18.2 to 18.8	13.8 to 16.3	18.5
Refractive index, n_D	-	-	-	-
Tensile strength, psi	3500-5500	7000-13000	5500-7000	8000-10500
Elongation, %	340 to 450	0.6 to 0.9	0.30 to 0.45	0.6 to 0.8
Tensile modulus, 10^5 psi	0.2 to 0.5	12 to 14	19.5	14 to 16
Compressive strength, psi $\times 10^{-3}$	-	25.0 to 45.0	30.0	30.0 to 35.0
Flexural strength, psi $\times 10^{-3}$	-	10.0 to 16.0	9.0 to 11.0	12.0 to 15.0
Impact strength, ft.-lb./in.	6 to 15	0.24 to 0.35	0.28 to 0.4	0.6 to 1.0
Hardness, Rockwell	600 (shore)	M110 to M125	M110	M120
Thermal conductivity 10^{-4} cal./sec./sq. cm., /10^3 cm./cm.)	5.8	7 to 10	13 to 17	10.6
Specific heat, cal./$^{\circ}$C per gm.	0.55	0.4	-	-
Thermal expansion, 10^{-3} per $^{\circ}$C	-	4.0	2.0 to 4.5	2.5 to 2.8
Resistance to heat, $^{\circ}$F (continuous)	160 to 212	210	250 to 400	250
Deflection temp., $^{\circ}$F	360 to 370	265	310	-
@ 264 psi fiber stress	-	-	-	-
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.	> 10 ¹⁶	10 ¹² to 10 ¹⁴	1.22x10 ¹²	10 ⁹ to 10 ¹⁰
Dielectric strength (short time) volts/mil	900 to 1100	300 to 400	410 to 430	250 to 350
(step-by-step) volts/mil	2.4 to 2.5	250 to 300	280 to 320	200 to 300
Dielectric constant, 60 cycles	-	7.9 to 9.5	6.4 to 10.2	7.6 to 12.6
10 ³ cycles	-	7.8 to 9.2	9.0	7.1 to 7.8
10 ⁶ cycles	-	7.2 to 8.4	6.1 to 6.7	6.5 to 6.9
Dissipation (power) factor 60 cycles	-	0.030 to 0.083	0.07 to 0.17	0.07 to 0.34
10 ³ cycles	-	0.015 to 0.036	0.07	0.03 to 0.05
10 ⁶ cycles	-	0.027 to 0.045	0.041 to 0.050	0.036 to 0.041
Arc resistance, sec,	-	110 to 180	120 to 180	115 to 125
Water absorption, 24 hr., %	0.1 to 1.4	0.1 to 0.6	0.08 to 0.14	0.3 to 0.6
Burning rate (flammability, in. /min.)	very slow	— self-extinguishing	— slight color change	— slight discoloration
Effect of sunlight	requires U. V.	— slight color change	— slight discoloration	
Effect of weak acids	resistant	none	none to slight	none
Effect of strong acids	attacked by	decomposes	decomposes	decomposes
Effect of weak alkalies	very resistant	none	very slight	none
Effect of strong alkalies	very resistant	attacked	slight attack	attacked
Effect of organic solvents	very resistant	none	none	none
Machining qualities	fair	fair	fair	good

PROPERTIES

	Nylons			20 to 40% Glass Filled
	Type 6/6	Type 6	Type 6/10	
Specific gravity (density)	1.13 to 1.15	1.12 to 1.14	1.09	1.3 to 1.52
Specific volume, cu. in./lb.	24.2 to 25.5	24.2 to 24.5	25.5	21.7 to 25.4
Refractive index, n_D	1.53	-	-	-
Tensile strength, psi	9000-12000	7000-14000	8500-8600	14000-35000
Elongation, %	60 to 300	25 to 320	85 to 300	1.5 to 6
Tensile modulus, 10^5 psi	1.75 to 4.1	1.5 to 3.8	1.6 to 2.8	8.6 to 18
Compressive strength, psi	$\times 10^{-3}$	6.7 to 12.5	7.2 to 13.0	15.0 to 24.0
Flexural strength, psi	$\times 10^{-3}$	no break	no break	18.0 to 40.0
Impact strength, ft.-lb/in.		1.0 to 2.0	1.0 to 4.0	1.2
Hardness, Rockwell		R108 to R118	R103 to R118	R111
Thermal conductivity 10^{-4} cal./sec./sq. cm., $1(^{\circ}\text{C.}/\text{cm.})$	5.85	5.85	5.16	1.5 to 1.7
Specific heat, cal./$^{\circ}\text{C}$ per gm.	0.4	0.38	0.4	0.3 to 0.35
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	8	8.3	9	1.2 to 3.2
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	180 to 300	175 to 250	-	300 to 400
Deflection temp., $^{\circ}\text{F}$				
@ 264 psi fiber stress	150 to 186	152 to 167	-	498 to 502
@ 66 psi fiber stress	360 to 365	300 to 365	300	507 to 510

Volume resistivity, ohm-cm.	10 ¹⁴ to 10 ¹⁵	10 ¹² to 10 ¹⁵	10 ¹⁴ to 10 ¹⁵	10 ¹⁴ to 10 ¹⁵	1.53-5.5x 10 ¹⁵
Dielectric strength (short time) volts/mil	385 to 470	440 to 510	-	-	408 to 503
(step-by-step) volts/mil	340 to 410	320 to 440	-	-	375 to 450
Dielectric constant, 60 cycles	4.0 to 4.6	3.9 to 5.5	3.9	4.0 to 4.6	4.0 to 4.6
10 ³ cycles	3.9 to 4.5	4.0 to 4.9	3.6	3.9 to 4.4	3.9 to 4.4
10 ⁶ cycles	3.4 to 3.6	3.5 to 4.7	3.5	3.4 to 3.9	3.4 to 3.9
Dissipation (power) factor 60 cycles	0.014 to 0.04	0.010 to 0.06	0.04	0.018 to 0.025	0.018 to 0.025
10 ³ cycles	0.02 to 0.04	0.011 to 0.06	0.04	0.020 to 0.025	0.020 to 0.025
10 ⁶ cycles	0.04	0.03 to 0.04	0.04	0.017 to 0.022	0.017 to 0.022
Arc resistance, sec.	130 to 140	-	-	-	92 to 148
Water absorption, 24 hr., %	1.5	1.6 to 1.88	0.4	0.2 to 1.1	non-burning
Burning rate (flammability, in./min.)	—	—	—	—	—
Effect of sunlight	—	—	—	—	—
Effect of weak acids	resistant	resistant	resistant	resistant	resistant
Effect of strong acids	attacked	attacked	attacked	attacked	attacked
Effect of weak alkalies	none	none	none	none	none
Effect of strong alkalies	none	none	none	none	surface only
Effect of organic solvents	— dissolved by phenols and formic acids —	—	—	—	resistant to most
Machining qualities	excellent	excellent	excellent	fair	fair

Polyacrylic Ester Molding Material		Phenol-Formaldehyde and Phenol-Furfural Molding Compounds		
PROPERTIES		No Filler	Woodflour and Cotton Flock Filler	Asbestos Filler
Specific gravity (density)	1.3 to 1.5	1.25 to 1.30	1.32 to 1.45	1.45 to 1.9
Specific volume, cu. in./lb.	18.5 to 21.3	21.3 to 22.2	17.8 to 20.9	11.9 to 20.9
Refractive index, n_D	-	1.5 to 1.7	-	-
Tensile strength, psi	1200-2000	7000-8000	6500-10000	5500-7500
Elongation, %	300 to 600	1.0 to 1.5	0.4 to 0.8	0.18 to 0.50
Tensile modulus, 10^5 psi	0.002 to 0.004	7.5 to 10	8 to 17	10 to 30
Compressive strength, psi $\times 10^{-3}$	-	10.0 to 30.0	22.0 to 36.0	20.0 to 35.0
Flexural strength, psi $\times 10^{-3}$	-	12.0 to 15.0	8.5 to 12.0	8.3 to 14.0
Impact strength, ft. -lb/in.	-	0.20 to 0.36	0.24 to 0.60	0.27 to 3.5
Hardness, Rockwell	40 to 90(Shore)	M124 to M128	M96 to M120	M95 to M115
Thermal conductivity 10^{-4} cal. / sec. /sq. cm., / $(^{\circ}\text{C.}/\text{cm.})$	-	3 to 6	4 to 7	8 to 22
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	-	0.38 to 0.42	0.35 to 0.40	0.28 to 0.32
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	-	2.5 to 6.0	3.0 to 4.5	0.8 to 4
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	250 to 350	250	350 to 360	350 to 500
Deflection temp., $^{\circ}\text{F}$	-	240 to 260	260 to 340	300 to 400
@ 264 psi fiber stress	-	-	-	-
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.	2x10 ¹¹ at 70°C	1.1x10 ¹²	10 ⁹ to 10 ¹³	10 ¹⁰ to 10 ¹³
Dielectric strength (short time) volts/mil	400 to 700 at 70°C	300 to 400	200 to 400	200 to 350
(step-by-step) volts/mil	-	250 to 350	100 to 375	150 to 300
Dielectric constant, 60 cycles	4 at 70°C	5 to 6.5	5.0 to 13	7.5 to 50
10 ³ cycles	-	4.5 to 6.0	4.4 to 9.0	6 to 30
10 ⁶ cycles	11	4.5 to 5.0	4.0 to 6.0	5.0 to 10.0
Dissipation (power) factor 60 cycles	2 at 70°C	0.06 to 0.10	0.05 to 0.30	0.1 to 0.3
10 ³ cycles	-	0.03 to 0.08	0.04 to 0.20	0.1 to 0.4
10 ⁶ cycles	-	0.015 to 0.03	0.03 to 0.07	0.4 to 0.8
Arc resistance, sec.	-	tracks	tracks	120 to 200
Water absorption, 24 hr., %	-	0.1 to 0.2	0.3 to 0.7	0.10 to 0.5
Burning rate (flammability, in./min.)	fast	very low	none	none
Effect of sunlight	none	surface darkens	general darkening	general darkening
Effect of weak acids	swells	none to slight	none to slight	none to slight
Effect of strong acids	swells	—	—	—
Effect of weak alkalies	swells	slight	— slight to marked	—
Effect of strong alkalies	swells	decomposes	attacked	attacked
Effect of organic solvents	attacked by some	fairly resistant	fairly resistant	fairly resistant
Machining qualities	-	fair to good	fair to good	good to poor

**Phenol-Formaldehyde and Phenol-Furfural
Molding Compounds**

PROPERTIES	Mica Filler	Glass Fiber Filler	Macerated Fabric and Cord Filler	Pulp Pre-formed and Molding Board
Specific gravity (density)	1.65 to 1.92	1.69 to 1.95	1.36 to 1.43	1.36 to 1.42
Specific volume, cu. in/lb.	14.3 to 15.8	14.1 to 15.8	19.4 to 20.4	19.6 to 20.4
Refractive index, n_D	-	-	-	-
Tensile strength, psi	6500-7000	5000-18000	3300-9000	4300-12000
Elongation, %	0.13 to 0.5	0.2	0.37 to 0.57	0.3 to 0.7
Tensile modulus, 10^5 psi	30 to 50	33	9 to 13	9 to 13
Compressive strength, psi	$\times 10^{-3}$	25.0 to 30.0	17.0 to 70.0	15.0 to 30.0
Flexural strength, psi	$\times 10^{-3}$	8.0 to 12.0	10.0 to 1.0	8.5 to 15.0
Impact strength, ft.-lb/in.		0.30 to 0.38	0.3 to 18	0.75 to 8.0
Hardness, Rockwell	M100 to M110	M95 to M100	M95 to M120	E60 to E85
Thermal conductivity 10^{-4} cal./sec./sq. cm., ($1^{\circ}\text{C}/\text{cm.}$)	10 to 14	9 to 14.5	4 to 9	4 to 7
Specific heat, cal./ $^{\circ}\text{C}$ per gm.	0.28 to 0.32	-	0.30 to 0.35	0.34 to 0.36
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	1.9 to 2.6	0.8 to 1.6	1 to 4	3.0 to 4.5
Resistance to heat, $^{\circ}\text{F}$. (continuous)	250 to 300	350 to 550	220 to 250	300 to 400
Deflection temp., $^{\circ}\text{F}$	300 to 350	300 to 600	250 to 300	260 to 340
@ 264 psi fiber stress	-	-	-	-
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm	10^{12} to $>10^{14}$	7×10^{12}	10^{11} to 10^{12}	10^{10} to 10^{13}
Dielectric strength				
(short time) volts/mil	350 to 400	140 to 400	200 to 400	250 to 550
(step-by-step) volts/mil	250 to 390	120 to 270	150 to 300	200 to 450
Dielectric constant, 60 cycles	4.7 to 6.0	7.1	6.0 to 21	5.0 to 8.0
10^3 cycles	4.4 to 5.5	6.9	5.0 to 11	5.0 to 8.0
10^6 cycles	4.2 to 5.2	4.6 to 6.6	4.5 to 7.0	4.0 to 7.0
Dissipation (power) factor 60 cycles	0.03 to 0.05	0.05	0.08 to 0.64	0.04 to 0.30
10^3 cycles	0.03 to 0.04	0.02	0.04 to 0.20	0.02 to 0.20
10^6 cycles	0.005 to 0.01	0.012 to 0.026	0.03 to 0.09	0.03 to 0.7
Arc resistance, sec.	4 to 190	tracks	2 to 130	
Water absorption, 24 hr., %	0.01 to 0.05	0.03 to 1.2	0.4 to 1.75	0.6 to 1.8
Burning rate (flammability, in./min.)	none	none	almost none	very low
Effect of sunlight		general darkening		
Effect of weak acids		none to slight		
Effect of strong acids				
Effect of weak alkalies		slight to marked		
Effect of strong alkalies	attacked	attacked	attacked	
Effect of organic solvents		fairly resistant		
Machining qualities	poor	-	fair to good	fair to good

Phenol-Formaldehyde and Phenol-Furfural
Compounded with Butadiene-Acrylonitrile
Copolymer

PROPERTIES	Woodflour and Cotton Flock Filler	Asbestos Filler	Rag Filler	Phenoxy
Specific gravity (density)	1.24 to 1.35	1.60 to 1.65	1.38 to 1.4	1.17 to 1.18
Specific volume, cu. in./lb.	20.5 to 22.3	16.8 to 17.3	21.0 to 21.3	23 to 23.6
Refractive index, n_D	-	-	-	1.5978
Tensile strength, psi	4500 to 7000	3500 to 4500	6500 to 7000	8000 to 9500
Elongation, %	0.75 to 2.25	-	-	50 to 100
Tensile modulus, 10^5 psi	4.0 to 6.0	5.0 to 9.0	3.5 to 6.0	3.4 to 3.8
Compressive strength, psi $\times 10^{-3}$	11.0 to 20.0	10.0 to 20.0	20.0 to 25.0	10.4 to 12.0
Flexural strength, psi $\times 10^{-3}$	7.0 to 12.0	6.0 to 8.0	9.5 to 10.0	12.0 to 14.0
Impact strength, ft.-lb/in.	0.35 to 1.0	0.30 to 0.40	2.0 to 2.3	2.3 to 12
Hardness, Rockwell	M37 to M85	M50	M97	R118 to R123
Thermal conductivity 10^{-4} cal. / sec. /sq. cm., / $1(C. / cm.)$	5	15	2.16	4.2
Specific heat, cal. / $^{\circ}C$ per gm.	0.33	-	-	0.4
Thermal expansion, 10^{-3} per $^{\circ}C$	1.5 to 4.0	4.0	-	5.7 to 6.1
Resistance to heat, $^{\circ}F.$ (continuous)	200	225	200	170
Deflection temp., $^{\circ}F$	230 to 260	275	300	175 to 188
@ 264 psi fiber stress		-	-	187 to 198
@ 66 psi fiber stress				

	10^{10} to 10^{11}	10^{11}	10^{11}	10^{11}	10^{10} to 10^{13}
Volume resistivity, ohm-cm.					
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	300 to 325 225 to 300	275 to 350 225 to 300	250 to 325 200 to 250	404 to 520 400 to 490	
Dielectric constant, 60 cycles 10^3 cycles 10^6 cycles	9 to 15 -	15 -	11.1 to 21 -	4.1 4.1	
Dissipation (power) factor 60 cycles 10^3 cycles 10^6 cycles	0.14 to 0.50 -	0.15 -	0.06 to 0.08 -	0.0012 0.002	
Arc resistance, sec.	tracks	tracks	tracks	tracks	
Water absorption, 24 hr., %	1 to 2	0.25 to 0.5	0.8 to 2	0.13	
Burning rate (flammability, in. / min.)	slow	very slow	slow	slow to self-extinguishing	
Effect of sunlight	darkens	darkens	darkens	slight discolor enbrittlement	
Effect of weak acids	none to slight	none to slight	none to slight	none	
Effect of strong acids				resistant	
Effect of weak alkalis		slight to marked		resistant	
Effect of strong alkalis	attacked	attacked	attacked	attacked	
Effect of organic solvents		fairly resistant		soluble in aromatics and chlorinated hydrocarbons	
Machining qualities	good	good	good	excellent	

PROPERTIES	Phenolic Cost Resins			Polycarbonate		
	No Filler	Mineral Filler	Unfilled	10 to 40% Glass Filled	1.24 to 1.52	18.2 to 22.4
Specific gravity (density)	1.30 to 1.32	1.68 to 1.70	1.2	-	-	-
Specific volume, cu.in/lb.	20.9 to 21.3	16.3 to 16.5	23	-	-	-
Refractive index, n _D	1.58 to 1.66	-	1.586	-	-	-
Tensile strength, psi	6000 to 9000	4000 to 9000	8000 to 9500	14000 to 20000	-	-
Elongation, %	1.5 to 2.0	-	60 to 100	0.9 to 5.0	-	-
Tensile modulus, 10 ⁵ psi	4 to 5	-	3.5	12 to 18.5	-	-
Compressive strength, psi $\times 10^{-3}$	12.0 to 15.0	29.0 to 34.0	12.5	16.0 to 19.0	-	-
Flexural strength, psi $\times 10^{-3}$	11.0 to 17.0	9.0 to 12.0	13.5	22.5 to 30.0	-	-
Impact strength, ft.-lb/in.	0.25 to 0.40	0.35 to 0.50	12 to 16	1.2 to 4	-	-
Hardness, Rockwell	M93 to M120	M85 to M120	M70 to R118	M88 to M95	-	-
Thermal conductivity 10 ⁻⁴ cal. / sec. / sq. cm. / 1(°C. / cm.)	3.5	-	4.6	2.5 to 5.2	-	-
Specific heat, cal. / °C per gm.	0.3 to 0.4	-	0.30	-	-	-
Thermal expansion, 10 ⁻³ per °C	6.8	7.5	6.6	1.2 to 3.8	-	-
Resistance to heat, °F. (continuous)	160	160	250	300	-	-
Deflection temp., °F	165 to 175	150 to 175	265 to 280	295 to 300	285	308 to 315
@ 264 psi fiber stress	-	-	-	-	-	-
@ 66 psi fiber stress	-	-	-	-	-	-

Volume resistivity, ohm-cm	10^{12} to 10^{13}	10^9 to 10^{12}	2.1×10^{16}	$1.4 - 1.52 \times 10^{15}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	350 to 400 250 to 300	100 to 250 75 to 200	400 364	475 475
Dielectric constant, 60 cycles 10^3 cycles 10^6 cycles	6.5 to 7.5 5.5 to 6.0 4.0 to 5.5	- 14 to 30 9 to 15	3.17 3.02 2.96	3.7 3.7 3.2 to 3.5
Dissipation (power) factor 60 cycles 10^3 cycles 10^6 cycles	0.10 to 0.15 0.01 to 0.05 0.04 to 0.05	- 0.10 to 0.30 0.07 to 0.20	0.0009 0.0021 0.010	0.003 to 0.005 0.002 to 0.004 0.009
Arc resistance, sec.	-	-	10 to 120	5 to 120
Water absorption, 24 hr., %	0.3 to 0.4	0.12 to 0.36	0.15	0.07 to 0.10
Burnir.g rate (flammability, in. /min.)	very slow	almost none	self-extinguishing	non-burning
Effect of sunlight	colors may fade	darkens	slight color change and embrittlement	none
Effect of weak acids	— none to slight —	—	none	none
Effect of strong acids	decomposed by oxidizing acids	attacked by oxidizing acids	attacked slowly	attacked by oxidizing acids
Effect of weak alkalies	slight to marked	nil	limited resistance	limited resistance
Effect of strong alkalies	decomposes	decomposed	attacked	attacked
Effect of organic solvents	attacked by some	attacked by some	soluble in aromatic & chlorinated hydrocarbons	soluble in chlorinated hydrocarbons
Machining qualities	excellent	good to fair	excellent	fair to good

Polyester and Alkyd Resins
Glass Reinforced

PROPERTIES	Cost	Preformed	Premix	Woven Cloth
	Polyester	Chopped Roving	Chopped Glass	
	Rigid			
Specific gravity (density)	1.10 to 1.46	1.35 to 2.3	1.8 to 2.3	1.50 to 2.1
Specific volume, cu.in./lb.	19.0 to 25.2	13.9 to 20.5	-	18.5 to 13.2
Refractive index, n_D	1.523 to 1.57	-	-	-
Tensile strength, psi	60000 to 130000	250000 to 300000	40000 to 100000	300000 to 50000
Elongation, %	<5	0.5 to 5.0	-	0.5 to 2.0
Tensile modulus, 10^5 psi	3.0 to 6.4	8.0 to 20.0	16 to 25	15.0 to 45.0
Compressive strength, psi $\times 10^{-3}$	13.0 to 36.5	15.0 to 30.0	20.0 to 30.0	25.0 to 50.0
Flexural strength, psi $\times 10^{-3}$	8.5 to 23.0	10.0 to 40.0	12.0 to 20.0	40.0 to 80.0
Impact strength, ft.-lb/in.	0.2 to 0.4	2 to 10	1.5 to 16.0	5 to 30
Hardness, Rockwell	M70 to M115	M70 to M120	60 to 80 (Barcol)	M80 to M120
Thermal conductivity 10^{-4} cal. / sec. / sq. cm. / $1(^{\circ}\text{C.} / \text{cm.})$	4	-	10 to 16	-
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	-	-	0.25	-
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	5.5 to 10	2 to 5	2.5 to 3.3	1.5 to 3
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	250	300 to 350	300 to 350	300 to 350
Deflection temp., $^{\circ}\text{F}$	140 to 400	-	>400	-
@ 264 psi fiber stress	@ 66 psi fiber stress	-	-	-

Volume resistivity, ohm-cm.	10^{14}	10^{14}	10^{12} to 10^{15}	10^{14}
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	380 to 500 280 to 420	350 to 500 -	345 to 420 275 to 390	350 to 500 -
Dielectric constant, 60 cycles	3.0 to 4.36	3.8 to 6.0	5.3 to 7.3	4.1 to 5.5
10^3 cycles	2.8 to 5.2	4.0 to 6.0	4.68	4.2 to 6.0
10^6 cycles	2.8 to 4.1	3.5 to 5.5	5.2 to 6.4	4.0 to 5.5
Dissipation (power) factor 60 cycles	0.003 to 0.028	0.01 to 0.04	0.011 to 0.041	0.01 to 0.04
10^3 cycles	0.005 to 0.025	0.01 to 0.05	-	0.01 to 0.06
10^6 cycles	0.006 to 0.026	0.01 to 0.03	0.008 to 0.022	0.01 to 0.03
Arc resistance, sec.	125	120 to 180	120 to 240	60 to 120
Water absorption, 24 hr., %	0.15 to 0.60	0.01 to 1.0	0.06 to 0.28	0.05 to 0.5
Burning rate (flammability, in. /min.)	1.1 to self-extinguishing	slow to self-extinguishing	slow to self-extinguishing	slow to self-extinguishing
Effect of sunlight	yellow; slightly slight	variable	slight	slight
Effect of weak acids	none	slight	slight	slight
Effect of strong acids	none to considerable	attacked	attacked	attacked
Effect of weak alkalies	none to slight	slight to attacked	slight to attacked	slight to attacked
Effect of strong alkalies	attacked	attacked	attacked	attacked
Effect of organic solvents	attacked by ketones and chlorinated solvents	slight	none	slight
Machining qualities	good	good	good	good

Polyester and Alkyd Molding Materials

PROPERTIES	Polyimides, Aromatic		
	Granular and Putty Types Mineral Filled	Asbestos Filled	Synthetic Fiber Filled
Specific gravity (density)	1.60 to 2.30	1.65	1.24 to 1.40
Specific volume, cu. in/lb.	5.4 to 12.3	16.8	22.3
Refractive index, n_D	-	-	-
Tensile strength, psi	3000 to 8000	4500 to 7000	4500 to 6000
Elongation, %	-	-	6 to 7
Tensile modulus, 10^5 psi	5 to 26	-	4.5
Compressive strength, psi	$\times 10^{-3}$	18.0 to 25.0	22.5
Flexural strength, psi	$\times 10^{-3}$	6.0 to 10.0	8.0 to 10.0
Impact strength, ft.-lb/in.	0.30 to 0.50	0.45 to 0.50	0.55 to 4.5
Hardness, Rockwell	60 to 70	M99	1.1
	(Barcol)	-	H85 to H95
Thermal conductivity 10^{-4} cal. / sec. / sq. cm. / $1(^{\circ}\text{C.} / \text{cm.})$	15 to 25	-	-
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	0.25	-	0.27
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	3.5 to 5	-	4 to 5
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	300 to 350	450	300 to 430
Deflection temp., $^{\circ}\text{F}$	350 to 425	315	240 to 290
@ 264 psi fiber stress	-	-	650
@ 66 psi fiber stress	-	-	-

Volume resistivity, ohm-cm.	10^{14}	6.6×10^8	10^8 to 10^{16}	$> 10^{16}$
Dielectric strength (short time) volts/mil	350 to 450	380	365 to 400	560
(step-by-step) volts/mil	300 to 350	290	330 to 350	-
Dielectric constant, 60 cycles	5.1 to 7.5	-	3.8	3.4
10^3 cycles	5.0 to 6.2	5.2	3.7	-
10^6 cycles	4.6 to 5.5	4.5	3.6	-
Dissipation (power) factor 60 cycles	0.009 to 0.06	-	0.026	-
10^3 cycles	0.01 to 0.03	0.11	0.02 to 0.03	-
10^6 cycles	0.015 to 0.04	0.04 to 0.06	0.01 to 0.016	-
Arc resistance, sec.	75 to 190	138	85 to 115	-
Water absorption, 24 hr., %	0.05 to 0.5	0.14	0.08 to 0.2	-
Burning rate (flammability, in. /min.)	slow to non-burning	self-extinguishing	self-extinguishing	-
Effect of sunlight	none	none	none	-
Effect of weak acids	none	none	none	-
Effect of strong acids	attacked	slight	slight	-
Effect of weak alkalies	attacked	none	none	-
Effect of strong alkalies	decomposes	slight	slight	-
Effect of organic solvents	none	none	none	-
Machining qualities	fair	good	excellent	-

PROPERTIES	Poly- Phenylene Oxide		Poly- Sulfone		Polyethylene	
	Low Density	High Density	Low Density	High Density	Low Density	High Density
Specific gravity (density)	1.06	1.24	0.910 to 0.925	0.941 to 0.965		
Specific volume, cu. in./lb.	26.1	22.3	30.0 to 30.5	28.8 to 29.6		
Refractive index, n_D	-	1.633	1.51	1.54		
Tensile strength, psi	11000	10200 (at yield)	10000 to 2300 (at yield)	3100 to 5500		
Elongation, %	50 to 80	50 to 100	90 to 800	15 to 100		
Tensile modulus, 10^5 psi	3.8	3.6	0.17 to 0.35	0.6 to 1.5		
Compressive strength, psi $\times 10^{-3}$	13.0	13.9 (at yield)	-	3.2		
Flexural strength, psi $\times 10^{-3}$	15.0	15.4 (at yield)	-	1.0		
Impact strength, ft. -lb/in.	1.5 to 1.9	1.2 (1/8" bar, -40°F)	no break	1.5 to 20		
Hardness, Rockwell	R118 to R120	M69, R120	D41 to D46 (Shore)	D60 to D70 (Shore)		
Thermal conductivity 10^{-4} cal./ sec./sq. cm., $/1(\text{C.}/\text{cm.})$	4.5	6.2	8.0	11 to 12.4		
Specific heat, cal./ $^{\circ}\text{C}$ per gm.	-	0.3	0.55	0.55		
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	2.7 to 3.1	5.6	16 to 18	11 to 13		
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	-	345	180 to 212	250		
Deflection temp., $^{\circ}\text{F}$	375	-	90 to 105	110 to 120		
@ 264 psi fiber stress			100 to 121	140 to 180		
@ 66 psi fiber stress						

Volume resistivity, ohm-cm	10 ¹⁷	5 x 10 ¹⁶	> 10 ¹⁶	> 10 ¹⁶
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	400 to 500 -	420 400	460 to 700 420 to 700	450 to 500 440 to 600
Dielectric constant, 60 cycles	2.58	3.14	2.25 to 2.35	2.30 to 2.35
10 ³ cycles	-	2.13	2.25 to 2.35	2.30 to 2.35
10 ⁶ cycles	2.58	3.10	2.25 to 2.35	2.30 to 2.35
Dissipation (power) factor 60 cycles	0.00035	0.0008	< 0.0005	< 0.0005
10 ³ cycles	-	0.0011	< 0.0005	< 0.0005
10 ⁶ cycles	0.0009	0.0056	< 0.0005	< 0.0005
Arc resistance, sec.	20 to 75	1.22	1.35 to 1.60	-
Water absorption, 24 hr., %	0.06	0.22	< 0.015	< 0.01
Burning rate (flammability, in./min.)	-	-	very slow (1.04)	very slow (1 to 1.04)
Effect of sunlight	-	strength loss	material crazes rapidly but resistant grades available	
Effect of weak acids	none	none	resistant	very resistant
Effect of strong acids	none	none	attacked by oxidizing acids	
Effect of weak alkalies	none	none	resistant	very resistant
Effect of strong alkalies	none	none	resistant	very resistant
Effect of organic solvents	soluble or swells in some	aliphatic - none aromatic - partly soluble	resistant (below 60°C)	resistant (below 80°C)
Machining abilities	excellent	good	excellent	

Polyethylene
Polypropylene

PROPERTIES	Ethylene Ethyl Acrylate Copolymer	Ethylene- Vinyl Acetate Copolymer	High Molecular Weight	Unmodified
Specific gravity (density)	0. 93	0. 92 to 0. 95	0. 94	0. 902 to 0. 906
Specific volume, cu. in/lb.	-	-	29. 8	30. 4 to 30. 8
Refractive index, n_D	-	-	-	1. 49
Tensile strength, psi	800 to 2000	1400 to 3800	5400	4300 to 5500
Elongation, %	300 to 700	650 to 900	525	200 to 700
Tensile modulus, 10^5 psi	0. 046 to 0. 067	0. 02 to 0. 07	1. 02	1. 6 to 2. 25
Compressive strength, psi $\times 10^{-3}$	-	-	-	5. 5 to 8. 0
Flexural strength, psi $\times 10^{-3}$	3. 0 to 3. 6	-	-	6. 0 to 8. 0
Impact strength, ft. -lb/in.	no break	no break	no break	0. 5 to 1. 5 @ 73° F
Hardness, Rockwell	D27 to D36 (Shore)	D30 to D95 (Shore)	55	R85 to R110
Thermal conductivity 10^{-4} cal. / sec. / sq. cm., / $1(^{\circ}\text{C.} / \text{cm.})$	-	-	-	2. 8
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	0. 55	0. 55	-	0. 46
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	16. 23	16 to 20	7. 2	5. 8 to 10. 2
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	190 to 200	-	-	250 to 320
Deflection temp., $^{\circ}\text{F}$	-	-	-	-
@ 264 psi fiber stress	-	140 to 147	163	135 to 145
@ 66 psi fiber stress	-	-	-	205 to 230

Volume resistivity, ohm-cm.	2.4×10^9	1.5×10^8	$> 10^{16}$	$> 10^{16}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	450 to 550 -	450 to 700 450	710 680	500 to 660 450 to 650
Dielectric constant, 60 cycles 10^3 cycles 10^6 cycles 10^6 cycles	2.7 to 2.9 2.7 to 2.9 2.7 to 2.8	2.5 to 3.15 2.6 to 2.98 2.6 to 2.8	- - 2.30	2.2 to 2.6 2.2 to 2.6 2.2 to 2.6
Dissipation (power) factor 60 cycles 10^3 cycles 10^6 cycles	0.01 to 0.02 0.01 to 0.02	0.003 to 0.02 0.003 to 0.02	- -	< 0.0005 < 0.0005 to 0.0018 < 0.005 to 0.0018
Arc resistance, sec.	-	-	-	185
Water absorption, 24 hr., %	0.04	0.03 to 0.05	< 0.01	0.03
Burning rate (flammability, in./min.)	very slow	very slow	very slow	slow
Effect of sunlight	—	—	—	craze rapidly resistant grades available
Effect of weak acids	resistant	resistant	-	none
Effect of strong acids	attacked by oxidizing acids	attacked	-	attacked slowly by oxidizing acids
Effect of weak alkalies	resistant	resistant	-	none
Effect of strong alkalies	resistant	resistant	-	very resistant
Effect of organic solvents	soluble in aromatic attacked in chlorinated	solvents over 50°C soluble in chlorinated	-	resistant below 80°C
Machining qualities	fair	fair	-	good

Polystrene		Styrene-Acrylonitrile Copolymer		Styrene Unfilled	
Properties		Impact-resist Type	Chemical Resistant Type	Impact-resist Medium-impact	General-Purpose
Specific gravity (density)	1.04 to 1.09	0.98 to 1.10	1.05 to 1.11	1.075 to 1.10	
Specific volume, cu. in./lb.	26.0 to 26.4	25.2 to 28.1	24.8 to 26.2	25.2 to 25.8	
Refractive index, n_D	1.59 to 1.60	-	1.57 to 1.60	1.56 to 1.57	
Tensile strength, psi	5000 to 12000	3000 to 6800	6500 to 12000	9500 to 12000	
Elongation, %	1.0 to 2.5	5 to 8.0	1.4 to 2.5	1.5 to 3.5	
Tensile modulus, 10^5 psi	4 to 6	2 to 4.5	4 to 6	4 to 5.6	
Compressive strength, psi	$\times 10^{-3}$	11.5 to 16.0	4.0 to 9.0	11.5 to 16.0	14.0 to 17.0
Flexural strength, psi	$\times 10^{-3}$	8.7 to 14.0	5.0 to 10.0	10.0 to 17.0	14.0 to 19.0
Impact strength, ft.-lb/in.		0.25 to 0.40 1/4" bar	0.5 to 11.0 1/4" bar	0.35 to 0.60 1/4" bar	0.35 to 0.50
Hardness, Rockwell	M65 to M80	M35 to M70	M65 to M90	M80 to M90	
Thermal conductivity 10^{-4} cal./sec./sq. cm., / $1(^{\circ}\text{C.}/\text{cm.})$	2.4 to 3.3	1.0 to 3.0	1.9 to 3.0	2.9	
Specific heat, cal./ $^{\circ}\text{C}$ per gm.	0.32	0.32 to 0.35	0.32 to 0.35	0.32 to 0.34	
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	6 to 8	3.4 to 21	6 to 8	3.6 to 8	
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	150 to 170	140 to 175	170 to 200	140 to 205	
Deflection temp., $^{\circ}\text{F}$		205 max.	180 to 235	190 to 215	
@ 264 psi fiber stress		-	-	-	
@ 66 psi fiber stress					

Volume resistivity, ohm-cm.	$> 10^{16}$	$> 10^{16}$	10^{13} to 10^{17}	$> 10^{16}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	500 to 700 400 to 600	300 to 600 300 to 600	400 to 600 300 to 500	400 to 500 300 to 600
Dielectric constant, 60 cycles	2.45 to 2.65	2.45 to 4.75	2.45 to 3.4	2.6 to 3.4
10 ³ cycles	2.4 to 2.65	2.4 to 4.5	2.4 to 3.2	2.5
10 ⁶ cycles	2.4 to 2.65	2.4 to 3.8	2.4 to 3.1	2.75 to 3.1
Dissipation (power) factor 60 cycles	10^{-4} to 3×10^{-4}	4×10^{-4} to 2×10^{-3}	5×10^{-4} to 3×10^{-3}	4×10^{-3} to 10^{-2}
10 ³ cycles	10^{-4} to 3×10^{-4}	4×10^{-4} to 2×10^{-3}	5×10^{-4} to 3×10^{-3}	7×10^{-3} to 10^{-2}
10 ⁶ cycles	10^{-4} to 4×10^{-4}	4×10^{-4} to 2×10^{-3}	5×10^{-4} to 5×10^{-3}	7×10^{-3} to 10^{-2}
Arc resistance, sec.	60 to 80	20 to 100	60 to 135	100 to 150
Water absorption, 24 hr., %	0.03 to 0.10	0.05 to 0.6	0.05 to 0.40	0.20 to 0.30
Burning rate (flammability, in./min.)	slow	slow	slow	slow
Effect of sunlight	yellow slightly	strength loss	— yellow slightly	—
Effect of weak acids	none	none	none	none
Effect of strong acids	—	attacked by oxidizing acids	—	—
Effect of weak alkalies	none	none	none	none
Effect of strong alkalies	none	none	none	none
Effect of organic solvents	soluble in aromatic and chlorinated hydrocarbons	—	—	—
Machining qualities	fair to good	good	fair to good	good

PROPERTIES	Silicones	Urea-Form-Aldehyde	Cast	Urethanes
	Cast Resin	α -Cellulose	Liquid	Urethane
Specific gravity (density)	1.05 to 1.23	1.47 to 1.52	1.2 to 2.5	1.24 to 1.26
Specific volume, cu. in./lb	-	18.2 to 18.8	21 to 23	22.0 to 22.3
Refractive index, n_D	1.43	1.54 to 1.56	-	-
Tensile strength, psi	800 to 1000	5500 to 13000	175 to 10000	5000 to 8000
Elongation, %	100	0.5 to 1.0	100 to 1000	100 to 600
Tensile modulus, 10^5 psi	900	10 to 15	80	0.1
Compressive strength, psi	$\times 10^{-3}$ 0.10	25.0 to 45.0	20.0	20.0
Flexural strength, psi	$\times 10^{-3}$ -	10.0 to 18.0	-	0.7 to 1.0
Impact strength, ft. -lb/in.	-	0.25 to 0.40	does not break	
Hardness, Rockwell	40-45 (Shore A)	M110 to M120	M28 to R60	M28 to R50
Thermal conductivity 10^{-4} cal. / sec. / sq. cm., / $1(^{\circ}\text{C.} / \text{cm.})$	3.5 to 7.5	7 to 10	5	5
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	-	0.4	0.42 to 0.44	0.42 to 0.44
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	25 to 30	2.2 to 3.6	10 to 20	10 to 20
Resistance to heat, $^{\circ}\text{F.}$ (Continuous)	400	170	190 to 250	190
Deflection temp., $^{\circ}\text{F}$	-	260 to 290	-	-
@ 264 psi fiber stress	-	-	-	-
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.

	2×10^{15}	10^{12} to 10^{13}	2×10^{11} to 10^{15}	2×10^{11}
Dielectric strength (short time) volts/mil	550	300 to 400	450 to 500	450 to 500
(step-by-step) volts/mil	550	220 to 300	450 to 500	450 to 500
Dielectric constant, 60 cycles	2.75 to 3.05	7.0 to 9.5	4 to 7.5	6.7 to 7.5
10^3 cycles	-	7.0 to 7.5	4 to 7.5	6.7 to 7.5
10^6 cycles	2.6 to 2.7	6 to 8	6.5 to 7.1	6.5 to 7.1
Dissipation (power) factor 60 cycles	0.007 to 0.001	0.035 to 0.043	0.015 to 0.017	0.015 to 0.017
10^3 cycles	-	0.025 to 0.035	0.050 to 0.060	0.050 to 0.060
10^6 cycles	0.001 to 0.002	0.25 to 0.35	-	-
Arc resistance, sec.	115 to 130	80 to 150	0.1 to 0.6	-
Water absorption, 24 hr., %	0.12 (7 days 77°F)	0.4 to 0.8	-	-
Burning rate (flammability, in. /min.)	— self-extinguishing —	slow	slow	slow
Effect of sunlight	none	pastels grey	none to yellow	none
Effect of weak acids	little or none	none to slight	slight	dissolves
Effect of strong acids	slight to severe	decomposes	attacked (moderate)	dissolves
Effect of weak alkalies	little or none	slight to marked	slight	dissolves
Effect of strong alkalies	moderate to severe	decomposes	attacked (moderate)	dissolves
Effect of organic solvents	attacked by some	none to slight	none to slight	resists most
Machining qualities	-	fair	excellent	fair to excellent

VINYL POLYMERS AND COPOLYMERS

PROPERTIES	Vinyl Butyral	Vinyl Chloride	Vinylidene Chloride	Polyvinyl Dichloride Compound
Molding Compounds	Molding Compounds	Molding Compounds	Molding Compounds	Molding Compounds
Unfilled	Flexible	Chloride Acetate	Chloride Acetate	Chloride Acetate
Specific gravity (density)	1.05	1.16 to 1.35	1.65 to 1.72	1.50 to 1.55
Specific volume, cu. in/lb.	26.2	20.5 to 23.8	16.1 to 16.8	17.8 to 18.4
Refractive index, n_D	1.47 to 1.49	-	1.60 to 1.63	-
Tensile strength, psi	500 to 3000	1500 to 3500	3000 to 5000	7500 to 9000
Elongation, %	150 to 450	200 to 450	up to 250	4.5
Tensile modulus, 10^5 psi	-	-	0.5 to 0.8	4.4×10^5
Compressive strength, psi	$\times 10^{-3}$	-	0.9 to 1.7	2.0 to 2.7
Flexural strength, psi	$\times 10^{-3}$	varies	-	4.2 to 6.2
Impact strength, ft. -lb/in.	varies	varies	0.3 to 1.0	14.5 to 17.0
Hardness, Rockwell	10 to 100 (Shore)	-	M50 to M65	117
Thermal conductivity 10^{-4} cal./ sec./sq. cm., /1($^{\circ}$C./cm.)	-	3.0 to 4.0	3.0	3.3×10^{-4}
Specific heat, cal. /$^{\circ}$C per gm.	-	0.3 to 0.5	0.32	3.3×10^{-4}
Thermal expansion, 10^{-3} per $^{\circ}$C	-	7 to 25	19	7
Resistance to heat, $^{\circ}$F. (continuous)	-	150 to 175	160 to 200	210
Deflection temp., $^{\circ}$F.	-	-	130 to 150	215 to 220
@ 264 psi fiber stress	-	-	-	247
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.	5×10^{10}	10^{11} to 10^{15}	10^{14} to 10^{16}	$7-18 \times 10^{15}$
Dielectric strength (short time) volts/mil	350	300 to 1000	400 to 600	1220
(step-by-step) volts/mil	325	275 to 900	400 to 600	-
Dielectric constant, 60 cycles	5.60	5.0 to 9.0	4.5 to 6.0	3.08
10^3 cycles	5.10	4.0 to 8.0	3.5 to 5.0	-
10^6 cycles	3.92	3.3 to 4.5	3.0 to 4.0	-
Dissipation (power) factor 60 cycles	0.115	0.08 to 0.15	0.03 to 0.045	0.01867 - 0.02080
	10^3 cycles	0.057	0.07 to 0.16	0.06 to 0.075
	10^6 cycles	0.061	0.04 to 0.14	0.05 to 0.08
Arc resistance, sec.	-	-	-	-
Water absorption, 24 hr., %	1.0 to 2.0	0.15 to 0.75	0.1	0.15
Burning rate (flammability, in. / min.)	slow	—	self - extinguishing	—
Effect of sunlight	slight	slight	slight	-
Effect of weak acids	slight	none	none	none
Effect of strong acids	slight	none to slight	resistant	none
Effect of weak alkalies	slight	none	resistant	none
Effect of strong alkalies	slight	none	resistant	none
Effect of organic solvents	soluble or swells in ketones and esters and aromatic hydro- carbons	none to slight	resists most	
Machining qualities	-	good	excellent	

TABLE 11
PHYSICAL PROPERTIES OF PLASTICS USED PRIMARILY AS FILMS
NOT LISTED IN TABLE 10

From Reference 243:
Physical Properties of Plastics Used Primarily as Films not Listed in Table 10

PROPERTIES	Polyester PE	Ethyl Cellulose	Terephthalate	Poly-Urethane Elastomer	Polyvinyl Fluoride
Specific gravity (density)	1.15	1.38 to 1.395	1.19 to 1.20	1.38	
Tensile strength, psi	8000 to 10000	25000	5000 to 9000	7000 to 18000	
Elongation, %	20 to 30	100; 50 (Type T)	50 to 100	115 to 250	
Resistance to heat, °F. (continuous)	250	300	190	220 to 250	
Volume resistivity, ohm-cm.	10 ¹⁵	10 ¹⁸	2.0 x 10 ¹¹	3 x 10 ¹³	
Dielectric strength volts/mil	1500 (10-mil)	7000 (1-mil)	450 to 500	4100	
Dielectric constant, 10 ³ cycles 10 ⁶ cycles	3.1 3.0	3.1 3.0	6.7 to 7.5 6.5 to 7.1	8.5 -	
Dissipation (power) Factor 10 ³ cycles 10 ⁶ cycles	0.002 to 0.020 0.010 to 0.060	0.0047 0.016	0.050 to 0.060	1.6 -	
Water absorption, 24 hr., %	2.5 to 7.5	0.8	0.55 to 0.77	< 0.5	
Burning rate (flammability, in. /min.)	slow burning	slow to self-extinguishing	slow burning	slow to self-extinguishing	
Resistance to sunlight	good to fair	medium to excellent	fair to excellent	excellent	
Resistance to strong acids	fair to poor	good	poor	excellent	
Resistance to strong alkalies	excellent	good	poor	excellent	
Resistance to organic solvents	poor	excellent	good	excellent	

PROPERTIES	Vinyl Chloride-Acetate Copolymers	Regenerated Cellulose (Cellophane)	Rubber Hydro- Chloride
Specific gravity (density)	Rigid 1.30 to 1.59	Nonrigid 1.20 to 1.45	1.40 to 1.50 1.11
Tensile strength, psi	5500 to 8000	1400	7000 to 18000 3500 to 5000
Elongation, %	2 to 10	150 to 500	10 to 50 200 to 800
Resistance to heat, °F. (continuous)	fair	150 to 200	300 180 to 205
Volume resistivity, ohm-cm.	10 ¹⁶	10 ¹¹ to 10 ¹⁴	10 ¹¹ 10 ¹³
Dielectric strength volts/mil	425 to 1300	250 to 1000	2000 to 2500 -
Dielectric constant, 10 ³ cycles	3.0 to 3.3	4.0 to 8.0	3.2 3
10 ⁶ cycles	2.8 to 3.1	3.3 to 4.5	- 3
Dissipation (power) factor 10 ³ cycles	0.009 to 0.017	0.070 to 0.160	0.015 -
10 ⁶ cycles	0.006 to 0.019	0.04 to 0.140	0.006 -
Water absorption, 24 hr., %	negligible	negligible	45 to 115 5
Burning rate (flammability, in. /min.)	— slow to self-extinguishing —	slow	self-extinguishing
Resistance to sunlight	good	good	fair
Resistance to strong acids	excellent	good	good
Resistance to strong alkalies	excellent	good	good
Resistance to organic solvents	poor to good	poor to good	-

A. S. T. M. Test Methods for Physical Properties Appearing in Table

Specific gravity (density)	D 792
Specific Volume, cu. in/lb.	D 792
Refractive index, n_D	D 542
Tensile strength, psi	D 638 D 651
Elongation, %	D 638
Tensile modulus, 10^5 psi	D 638
Compressive strength, psi	D 695
Flexural strength, psi	D 790
Impact strength, ft. lb/in of notch (1/2 x 1/2 on. notched bar)	D 256
Hardness, Rockwell	D 785
Flexural modulus	D 790
Compressive modulus	D 695
Thermal conductivity, 10^{-4} cal./sec./ sq. cm., /1($^{\circ}$C./cm.)	C 177
Thermal expansion, 10^{-3} per $^{\circ}$C.	D 696
Deflection temp., $^{\circ}$F 264 & 66 psi fiber stress	D 648
Volume resistivity, ohm-cm. (50% RH and 23$^{\circ}$C.)	D 257
Dielectric strength, short time, 1/8-in. thickness, volts/mil	D 149
Dielectric strength, step-by-step, 1/8-in. thickness, volts/mil	D 149
Dielectric constant, 60 cycles	D 150
Dielectric constant, 10^3 cycles	D 150
Dielectric constant, 10^6 cycles	D 150

Dissipation (power) factor, 60 cycles	D 150
10^3 cycles	D 150
10^6 cycles	D 150
Arc resistance, sec.	D 495
Water absorption, 24 hr., 1/8-in. thickness, %	D 570
Burning rate (or flammability, in./min.)	D 635
Effect of weak acids	D 543
Effect of strong acids	D 543
Effect of weak alkalies	D 543
Effect of strong alkalies	D 543
Effect of organic solvents	D 543

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